

MILITARY SPECIFICATION

MICROCIRCUITS, LINEAR, CMOS/ANALOG  
 MULTIPLEXERS/DEMULTIPLEXERS WITH OVERVOLTAGE PROTECTION,  
 MONOLITHIC SILICON, POSITIVE LOGIC

This specification is approved for use by all Depart-  
 ments and Agencies of the Department of Defense.

1. SCOPE

1.1 Scope. This specification covers the detail requirements for monolithic silicon, CMOS/Analog logic microcircuits. Two product assurance classes and a choice of case outlines and lead finishes are provided for each type and are reflected in the complete part number.

1.2 Part number. The part number shall be in accordance with MIL-M-38510.

1.2.1 Device type. The device type shall be as follows:

<u>Device type</u>	<u>Circuit</u>
01	Single 16-channel MUX/DEMUX
02	Single 16-channel MUX/DEMUX with overvoltage protection
03	Differential 8-channel MUX/DEMUX
04	Differential 8-channel MUX/DEMUX with overvoltage protection
05	Single 8-channel MUX/DEMUX with overvoltage protection
06	Differential 4-channel MUX/DEMUX with overvoltage protection
07	Single 8-channel MUX/DEMUX
08	Differential 4-channel MUX/DEMUX

1.2.2 Device class. The device class shall be the product assurance level as defined in MIL-M-38510.

1.2.3 Case outline. The case outline shall be designated as follows:

<u>Letter</u>	<u>Case outline (see MIL-M-38510, appendix C)</u>
E	D-2 (16-lead, 1/4" x 7/8"), dual-in-line package
X	See figure 4 (28-lead, 9/16" x 1-7/16"), dual-in-line package

1.3 Absolute maximum ratings:

Supply voltage between V+ and V-:  
 Device types 02, 04, 05, and 06- - - - +40 V  
 Device types 01, 03, 07, and 08- - - - +32 V

V+ to ground:  
 Device types 02, 04, 05, and 06- - - - +20 V  
 Device types 01, 03, 07, and 08- - - - +16 V

Digital input voltage:  
 Device types 02, 04, 05, and 06- - - -  $((V-)-4 V) \leq V_D \leq ((V+)+4 V)$   
 Device types 01, 03, 07, and 08- - - -  $-0.3 V \leq V_D \leq (V+)$

Beneficial comments (recommendations, additions, deletions) and any pertinent data which may be of use in improving this document should be addressed to: NASA Part Project Office, Code 311.A NASA/Goddard Space Flight Center, Greenbelt, MD 20771, by using the self-addressed Standardization Document Improvement Proposal (DD Form 1426) appearing at the end of this document or by letter.

Analog input:

Device types 02, 04, 05, and 06- - -	$((V-)-20 V < V_A \leq ((V+)+20 V)$
Device types 01, 03, 07, and 08- - -	$(V-) \leq V_A \leq (V+)$
Storage temperature - - - - -	-65°C to +150°C
Lead temperature (soldering 10 seconds)- - - - -	300°C
Junction temperature (T <sub>J</sub> )- - - - -	175°C

1.4 Recommended operating conditions:

V+	- - - - -	+15 V
V-	- - - - -	-15 V
V <sub>REF</sub>	- - - - -	Open
V <sub>IL</sub> (max)	- - - - -	0.8 V
V <sub>IH</sub> (min)	- - - - -	- - - - -
Device types 01, 03, 07, and 08- - -	- - - - -	2.4 V
Device types 02, 04, 05, and 06- - -	- - - - -	4.0 V
V <sub>EN</sub>	- - - - -	- - - - -
Device types 02, 04, 05, and 06- - -	- - - - -	4.0 V
Device types 01, 03, 07, and 08- - -	- - - - -	4.5 V
Ambient operating temperature range (T <sub>A</sub> ) - - - - -	- - - - -	-55°C to +125°C

1.5 Power and thermal characteristics.

Package	Case outline	Maximum allowable power dissipation <u>1/</u>	Maximum $\theta_{JC}$ <u>2/</u>	Maximum $\theta_{JA}$
16-lead DIP	E	400 mW @ T <sub>A</sub> = 125°C	50°C/W	125°C/W
28-lead DIP	X	400 mW @ T <sub>A</sub> = 125°C	51°C/W	125°C/W

2. APPLICABLE DOCUMENTS

2.1 Government documents

2.1.1 Specification and standard. Unless otherwise specified, the following specification and standard form a part of this specification to the extent specified herein. Unless otherwise specified, the issues of these documents shall be those listed in the issue of the Department of Defense Index of Specifications and Standards (DODISS) and supplement thereto, cited in the solicitation.

SPECIFICATION

MILITARY

MIL-M-38510 - Microcircuits, General Specification for.

STANDARD

MILITARY

MIL-STD-883 - Test Methods and Procedures for Microelectronics.

(Copies of the specification and standard required by contractors in connection with specific acquisition functions should be obtained from the contracting activity or as directed by the contracting activity.)

1/ All leads welded or soldered to PC board.

2/ Applies only when T<sub>A</sub> ≥ 75°C.

2.2 Order of precedence. In the event of a conflict between the text of this specification and the references cited herein (except for associated detail specifications, specification sheets or MS standards), the text of this specification shall take precedence. Nothing in this specification, however, shall supersede applicable laws and regulations unless a specific exemption has been obtained.

### 3. REQUIREMENTS

3.1 Detail specification. The individual item requirements shall be in accordance with MIL-M-38510, and as specified herein.

3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-M-38510 and herein. Although eutectic die bonding is preferred, epoxy die bonding may be performed. However, the resin used shall be Dupont 5504A conductive silver paste, or equivalent, which is cured at 200°C ±10°C for a minimum of 2 hours. The use of equivalent epoxies or cure cycles shall be approved by the qualifying activity. Equivalency shall be demonstrated in data submitted to the qualifying activity for verification.

3.2.1 Terminal connections. The terminal connections shall be as specified on figure 1.

3.2.2 Functional diagrams. The function diagrams shall be as specified on figure 2.

3.2.3 Truth tables. The truth tables shall be as specified on figure 3.

3.2.4 Case outlines. The case outline "X" shall be as specified on figure 4, and case outline "E" shall be as specified in 1.2.3.

3.2.5 Schematic circuits. The schematic circuits shall be submitted to the preparing activity prior to inclusion of a manufacturer's device in this specification and shall be submitted to the qualifying activity and agent activity (DESC-ECS) as a prerequisite for qualification. All qualified manufacturer's schematics shall be maintained by the agent activity and will be available upon request.

3.2.6 Package and sealing material. Package and sealing material shall be in accordance with MIL-M-38510.

3.3 Lead material and finish. The lead material and finish shall be in accordance with MIL-M-38510 (see 6.5).

3.4 Electrical performance characteristics. The electrical performance characteristics are as specified in table I, and apply over the full recommended ambient operating temperature range, unless otherwise specified.

3.5 Electrical test requirements. The electrical test requirements for each device class shall be the subgroups specified in table II. The electrical tests for each subgroup are described in table III.

3.6 Marking. Marking shall be in accordance with MIL-M-38510 and 1.2 herein.

3.6.1 Serialization. All class S devices shall be serialized in accordance with MIL-M-38510.

3.6.2 Correctness of indexing and marking. All devices shall be subjected to the final electrical tests in table II after part number marking, to verify that they are correctly indexed and identified by part number. Optionally, an approved electrical test may be devised especially for this requirement.

3.7 Microcircuit group assignment. The devices covered by this specification shall be in microcircuit group number 82 (see MIL-M-38510, appendix E).

### 4. PRODUCT ASSURANCE PROVISIONS

4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with MIL-M-38510 and methods 5005 and 5007, as applicable, of MIL-STD-883, except as modified herein.

4.2 Screening. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to qualification and quality conformance inspection. The following additional criteria shall apply:

- a. Burn-in tests (method 1015 of MIL-STD-883).
  - (1) For class S devices: dynamic test (test condition D) using the circuit shown on figure 7. Test duration shall be 240 hours minimum. Static test (test condition C) using the circuit shown on figure 6. Test duration shall be 48 hours minimum.
  - (2) For class B devices: Test condition A using the circuit shown on figure 6 or test condition D using the circuit shown on figure 7 or test condition F using an accelerated burn-in circuit approved by the qualifying activity.

NOTE: Burn-in circuit resistor tolerances for figures 6 and 7 shall be  $\pm 10$  percent.
- b. Interim and final electrical parameters shall be as specified in table II, except interim electrical parameters test prior to burn-in is optional at the discretion of the manufacturer.
- c. The percent defective allowable (PDA) for class S and class B devices shall be as specified in MIL-M-38510, based on failures from group A, subgroup 1 test after cooldown as final electrical test in accordance with method 5004 of MIL-STD-883 and with no intervening electrical measurements. If interim electrical parameter tests are performed prior to burn-in, failures resulting from pre burn-in screening may be excluded from the PDA. If interim electrical parameter tests prior to burn-in are omitted, then all screening failures shall be included in the PDA. The verified failures of group A, subgroup 1 after burn-in divided by the total number of devices submitted for burn-in in that lot shall be used to determine the percent defective for that lot, and the lot shall be accepted or rejected based on the PDA for the applicable device class.

4.3 Qualification inspection. Qualification inspection shall be in accordance with MIL-M-38510. Inspections to be performed shall be those specified in method 5005 of MIL-STD-883 and herein for groups A, B, C, and D inspections (see 4.4.1 through 4.4.4).

4.4 Quality conformance inspection. Quality conformance inspection shall be in accordance with MIL-M-38510 and as specified herein. Inspections to be performed shall be those specified in method 5005 of MIL-STD-883 and herein for groups A, B, C, and D inspections (see 4.4.1 through 4.4.4).

4.4.1 Group A inspection. Group A inspection shall be in accordance with table I of method 5005 of MIL-STD-883 and as follows:

- a. Tests shall be as specified in table II herein.
- b. Subgroups 5, 6, 7, and 8 of method 5005 of MIL-STD-883 shall be omitted.
- c. Subgroup 4 (Ci measurements) shall be measured only for initial qualification and after process or design changes which may affect input capacitance. Capacitance shall be measured between the designated terminal and GND at a frequency of 1 MHz. Subgroup 4 shall be performed using a sample of 5 devices with no failures allowed.
- d. Subgroup 13 shall be added to group A inspection using an LTPD of 10 and shall consist of the tests, conditions, and limits as specified in table III.
- e. Subgroup 12 shall be performed for initial qualification only using a sample of 5 devices for each device type submitted to group A inspections with no failures allowed. If not more than 1 failure is found in the first sample of 5, a second sample of 5 is permitted with no further failures allowed.

TABLE I. Electrical performance characteristics.

Characteristic	Symbol	Conditions 1/ 2/ V- = -15 V, V+ = +15 V, VEN = 4.5 V, GND = 0 V -55°C < TA < 125°C Unless otherwise specified	Device type	Limits		Unit
				Min	Max	
Positive input clamping voltage	VIC(POS)	TA = 25°C, V+ = V- = 0 V IN = 1 mA	02,04,05, 06		1.5	V dc
Negative input clamping voltage	VIC(NEG)	TA = 25°C, V+ = V- = 0 V IN = -1 mA	02,04,05, 06	-1.5		
Input leakage current 3/	I <sub>IH</sub>	Measure address inputs sequentially, connect all unused address inputs to GND	All	-0.1	+1.0	μA
Input leakage current 3/	I <sub>IL</sub>	Measure address inputs sequentially connect all unused address inputs to 5 V	All	-1.0	+0.1	
Leakage current into the source terminal of an "OFF" switch	I <sub>S(OFF)</sub>	VS = 10 V, VEN = 0.8 V All unused sources = -10 V TA = 25°C -55°C ≤ TA ≤ 125°C	All	-1	1	nA
			All	-50	50	
		VS = -10 V, VEN = 0.8 V All unused sources to +10 V TA = 25°C -55°C ≤ TA ≤ 125°C	All	-1	1	
			All	-50	50	
Leakage current into the drain terminal of an "OFF" switch	I <sub>D+(OFF)</sub>	VD = 10 V, VEN = 0.8 V All unused sources to -10 V TA = 25°C -55°C ≤ TA ≤ 125°C	01,02	-20	20	nA
			03,04, 05,06, 07,08	-10	10	
			01,02,	-500	500	
			03,04, 05,07, 06,08	-250	250	
				-125	125	
	I <sub>D-(OFF)</sub>	VD = 10 V, VEN = 0.8 V All unused sources to -10 V TA = 25°C -55°C ≤ TA ≤ 125°C	01,02	-20	20	
			03,04, 05,06, 07,08	-10	10	
			01,02,	-500	500	
			03,04, 05,07, 06,08	-250	250	
				-125	125	

See footnotes at end of table.

TABLE I. Electrical performance characteristics - Continued.

Characteristic	Symbol	Conditions 1/ 2/ V <sub>-</sub> = -15 V, V <sub>+</sub> = +15 V, V <sub>EN</sub> = 4.5 V, GND = 0 V -55°C ≤ T <sub>A</sub> ≤ 125°C Unless otherwise specified	Device type	Limits		Unit	
				Min	Max		
Leakage current from an "ON" driver into the switch (drain)	I <sub>D(ON)</sub>	V <sub>S</sub> = 10 V, V <sub>D</sub> = 10 V Connect all unused sources to -10 V T <sub>A</sub> = 25°C -55°C ≤ T <sub>A</sub> ≤ 125°C	01,02	-20	20	nA	
			03,04, 05,06, 07,08	-10	10		
			01,02,	-500	500		
			03,04, 05,07	-250	250		
			06,08	-125	125		
			01,02	-20	20		
		V <sub>S</sub> = 10 V, V <sub>D</sub> = -10 V Connect all unused sources to 10 V T <sub>A</sub> = 25°C -55°C ≤ T <sub>A</sub> ≤ 125°C	03,04, 05,06, 07,08	-10	10		
			01,02,	-500	500		
			03,04, 05,07	-250	250		
			06,08	-125	125		
			02,04,05, 06	-2.0	2.0		μA
			02,04,05, 06	-2.0	2.0		
Positive supply current	I(+)	V <sub>A</sub> = 0 V, V <sub>EN</sub> = 5 V	01,03		14	mA	
			02,04,05, 06		2.0		
			07,08		12		
Negative supply current	I(-)	V <sub>A</sub> = 0 V, V <sub>EN</sub> = 5 V	01,03	-14			
			02,04,05, 06	-1			
			07,08	-12			
Standby positive supply current	I+SBY	V <sub>A</sub> = 0 V, V <sub>EN</sub> = 0 V	01,03		3.0	mA	
			02,04,05, 06		2.0		
			07,08		3.5		
Standby negative supply current	I-SBY	V <sub>A</sub> = 0 V, V <sub>EN</sub> = 0 V	01,03	-4.0			
			02,04,05, 06	-1.0			
			07,08	-3.5			

See footnotes at end of table.

TABLE I. Electrical performance characteristics - Continued.

Characteristic	Symbol	Conditions 1/ 2/ V- = -15 V, V+ = +15 V, VEN = 4.5 V, GND = 0 V -55°C < TA < 125°C Unless otherwise specified		Device type	Limits		Unit	
					Min	Max		
Capacitance: Address	CA	V+ = V- = 0 V, TA = 25°C f = 1 MHz		A11		10	pF	
Capacitance: Enable	CEN	V+ = V- = 0 V, TA = 25°C f = 1 MHz		A11		10	pF	
Capacitance: Output switch	COS	V+ = V- = 0 V See table III		01		90	pF	
				02		85		
				03,04		50		
				05,07		45		
				06,08		25		
Capacitance: Input switch	CIS	V+ = V- = 0 V See table III		A11		10		
Switch "ON" resistance	RDS1	VS = 10 V	ID = 1 mA	TA = 25°C TA = -55°C	01,03	600	Ω	
				TA = 125°C				700
				ID = 100 μA	TA = 25°C TA = -55°C	02,04		1,500
					TA = 125°C			2,000
			ID = 1 mA	TA = 25°C TA = -55°C	05,06	1,500		
				TA = 125°C		1,800		
			ID = 1 mA	TA = 25°C TA = -55°C	07,08	400		
				TA = 125°C		500		

See footnotes at end of table.

TABLE I. Electrical performance characteristics - Continued.

Characteristic	Symbol	Conditions 1/ 2/ V- = -15 V, V+ = +15 V, V <sub>EN</sub> = 4.5 V, GND = 0 V -55°C < T <sub>A</sub> < 125°C Unless otherwise specified		Device type	Limits		Unit		
					Min	Max			
Switch "ON" resistance	R <sub>DS1</sub>	V <sub>S</sub> = -10 V	I <sub>D</sub> = -1 mA	T <sub>A</sub> = 25°C T <sub>A</sub> = -55°C	01,03		600	Ω	
						T <sub>A</sub> = 125°C			700
				I <sub>D</sub> = -100 μA	T <sub>A</sub> = 25°C T <sub>A</sub> = -55°C	02,04		1,500	
							T <sub>A</sub> = 125°C		2,000
				T <sub>A</sub> = 25°C T <sub>A</sub> = -55°C	05,06		1,500		
						T <sub>A</sub> = 125°C		1,800	
			I <sub>D</sub> = -1 mA	T <sub>A</sub> = 25°C T <sub>A</sub> = -55°C	07,08		400		
						T <sub>A</sub> = 125°C		500	
			R <sub>DS2</sub>	V <sub>S</sub> = 7.5 V	V <sub>S</sub> = 7.5 V	I <sub>D</sub> = 1 mA	01,03,07, 08		1,000
								I <sub>D</sub> = 100 μA	02,04
05,06	2,200								
V <sub>S</sub> = -7.5 V	I <sub>D</sub> = -1 mA	01,03,07, 08				1,000			
					I <sub>D</sub> = -100 μA	02,04	2,400		
						05,06	2,200		
Single channel isolation	V <sub>ISO</sub>	f = 200 kHz, V <sub>GEN</sub> = 1 V <sub>p-p</sub> See figure 17	A11	50		dB			
Crosstalk between channels	V <sub>CT</sub>	f = 200 kHz, V <sub>GEN</sub> = 1 V <sub>p-p</sub> See figure 18	A11	50		dB			
Charge transfer error	V <sub>CTE</sub>	V <sub>S</sub> = GND, see figure 19	A11		10	mV			

See footnotes at end of table.

TABLE I. Electrical performance characteristics - Continued.

Characteristic	Symbol	Conditions <u>1/</u> <u>2/</u> V <sub>-</sub> = -15 V, V <sub>+</sub> = +15 V, V <sub>EN</sub> = 4.5 V, GND = 0 V -55°C < T <sub>A</sub> < 125°C Unless otherwise specified		Device type	Limits		Unit
					Min	Max	
Break-before-make time delay	t <sub>D</sub>	See figure 16	T <sub>A</sub> = 25°C	All	5		ns
Propagation delay times: Address inputs to I/O channels	t <sub>ON(A)</sub> t <sub>OFF(A)</sub>	R <sub>L</sub> = 1 kΩ C <sub>L</sub> = 100 pF See figures 8, 10, 12, and 14	T <sub>A</sub> = 25°C	All		1,000	ns
			T <sub>A</sub> = -55°C			1,500	
Enable to I/O	t <sub>ON(EN)</sub> t <sub>OFF(EN)</sub>	R <sub>L</sub> = 1 kΩ C <sub>L</sub> = 100 pF See figures 9, 11, 13, and 15	T <sub>A</sub> = 25°C	All		1,000	
			T <sub>A</sub> = -55°C			1,500	
			T <sub>A</sub> = 125°C			1,500	

1/ Current flowing in either direction between any associated input and output terminals of the switch shall be 30 mA maximum.

2/ Input = source; Output = drain.

3/ Input current of one input node.

TABLE II. Electrical test requirements.

MIL-STD-883 test requirements	Subgroups (see table III) <u>1/</u> , <u>2/</u> , <u>3/</u>	
	Class S <u>4/</u>	Class B
Interim electrical parameters (method 5004)	1	1
Final electrical parameters (method 5004)	1,2,3,9	1,2,3,9,
Group A test requirements (method 5005)	1,2,3,4,9, 10,11,12,13	1,2,3,4,9, 12,13
Group B test requirements (method 5005)	1, 2, 3 and table IV delta limits	N/A
Group C end-point electrical parameters (method 5005)	N/A	1 and table IV delta limits
Additional electrical subgroups for group C periodic inspection	N/A	10,11,12
Group D end-point electrical parameters (method 5005)	1, 2, 3	1
Additional electrical subgroups for group D periodic inspection	12**	None

1/ PDA applies to subgroup 1 (see 4.2c).

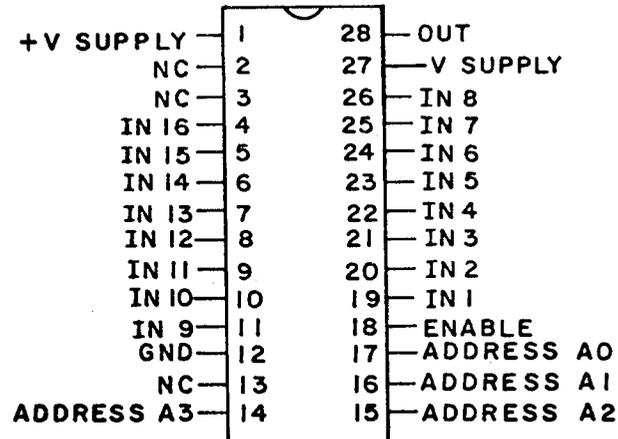
2/ See 4.4.1c.

3/ See 4.4.1e.

4/ See 4.4.4b.

Device type 01

Case X



Device type 02

Case X

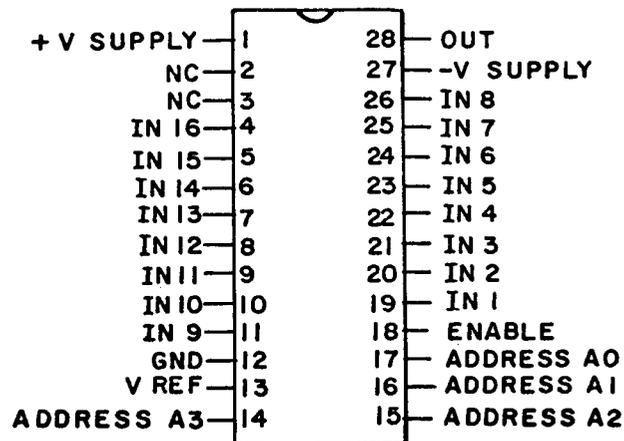
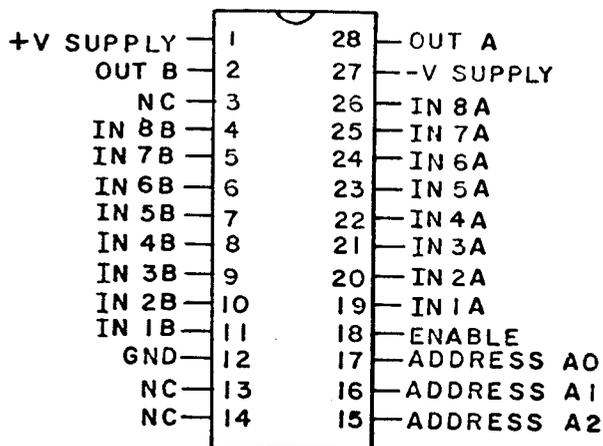


FIGURE 1. Terminal connections.

Device type 03

Case X



Device type 04

Case X

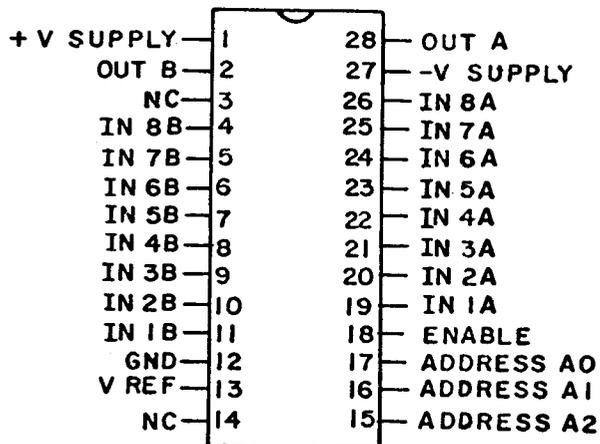
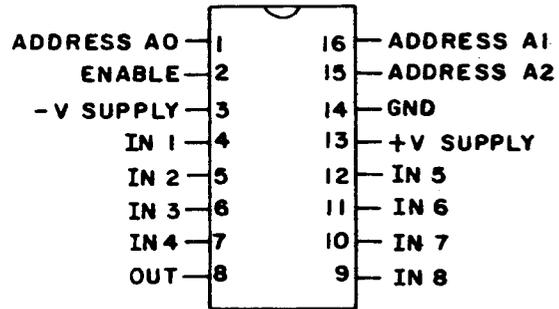


FIGURE 1. Terminal connections - Continued.

Device types 05 and 07

Case E



Device types 06 and 08

Case E

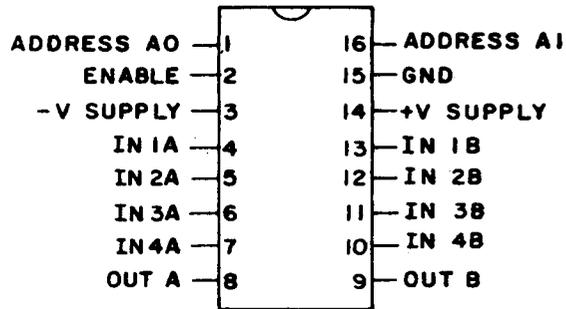


FIGURE 1. Terminal connections - Continued.

Device types 01 and 02

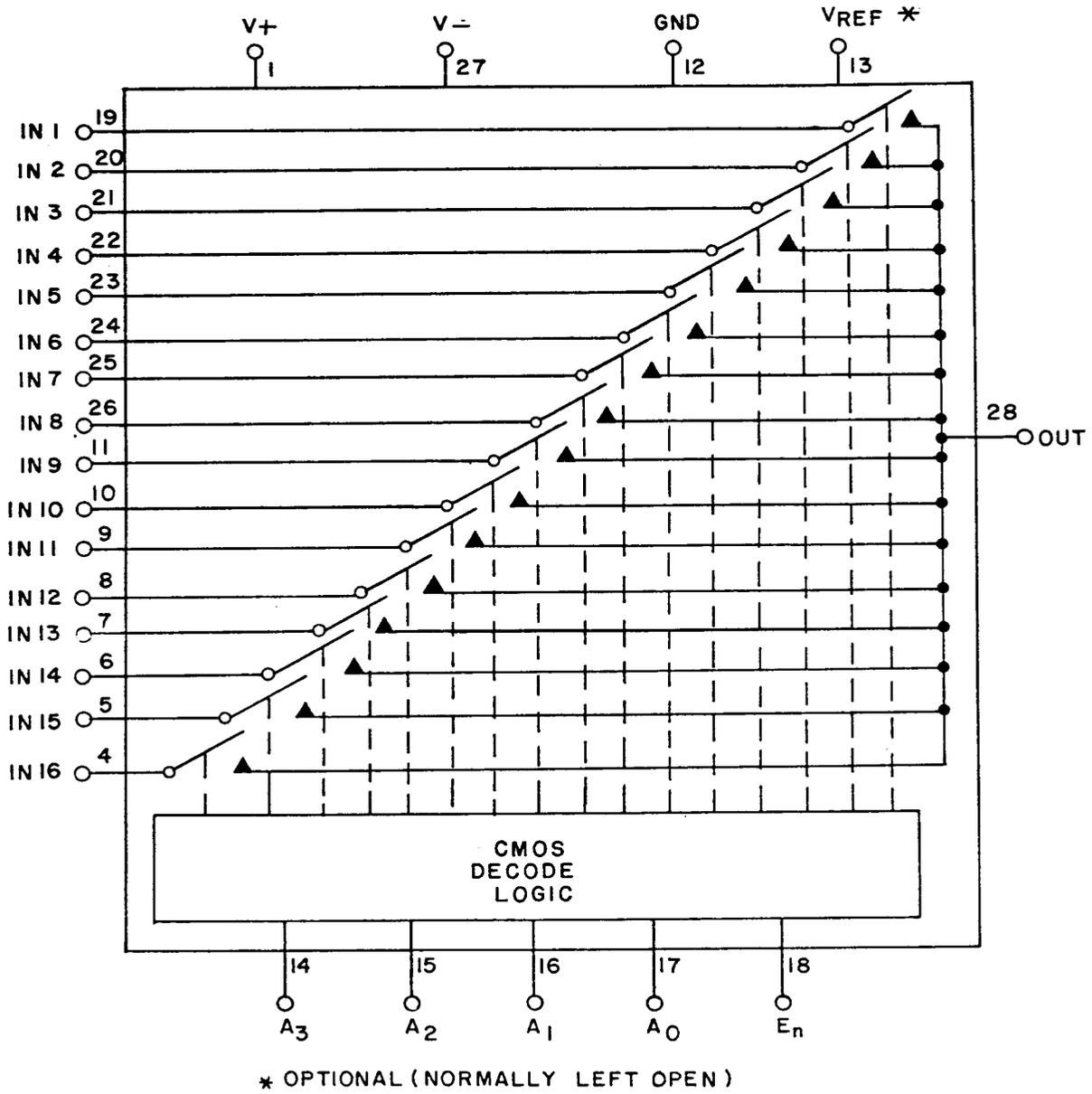


FIGURE 2. Functional diagrams.

Device types 03 and 04

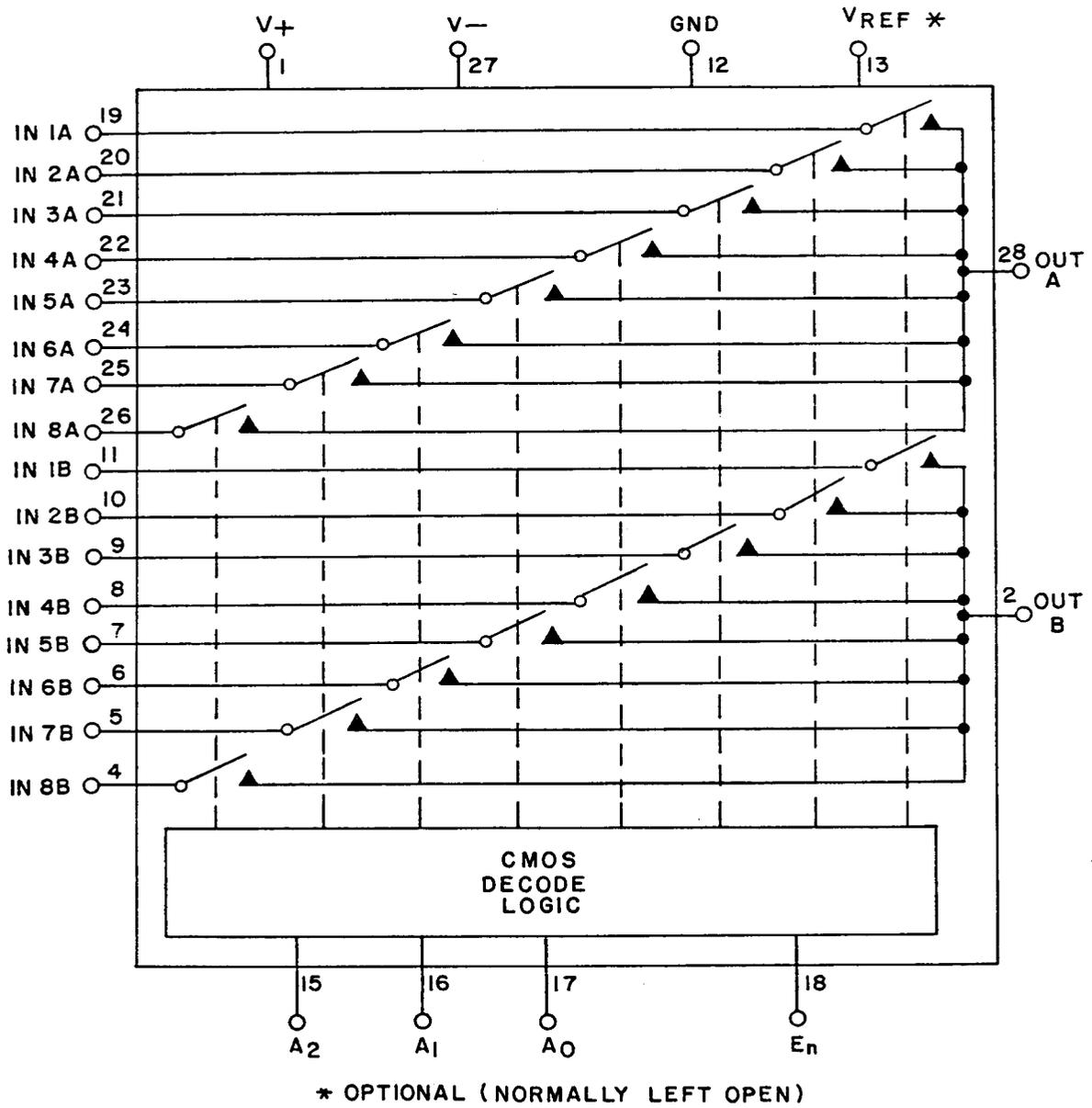
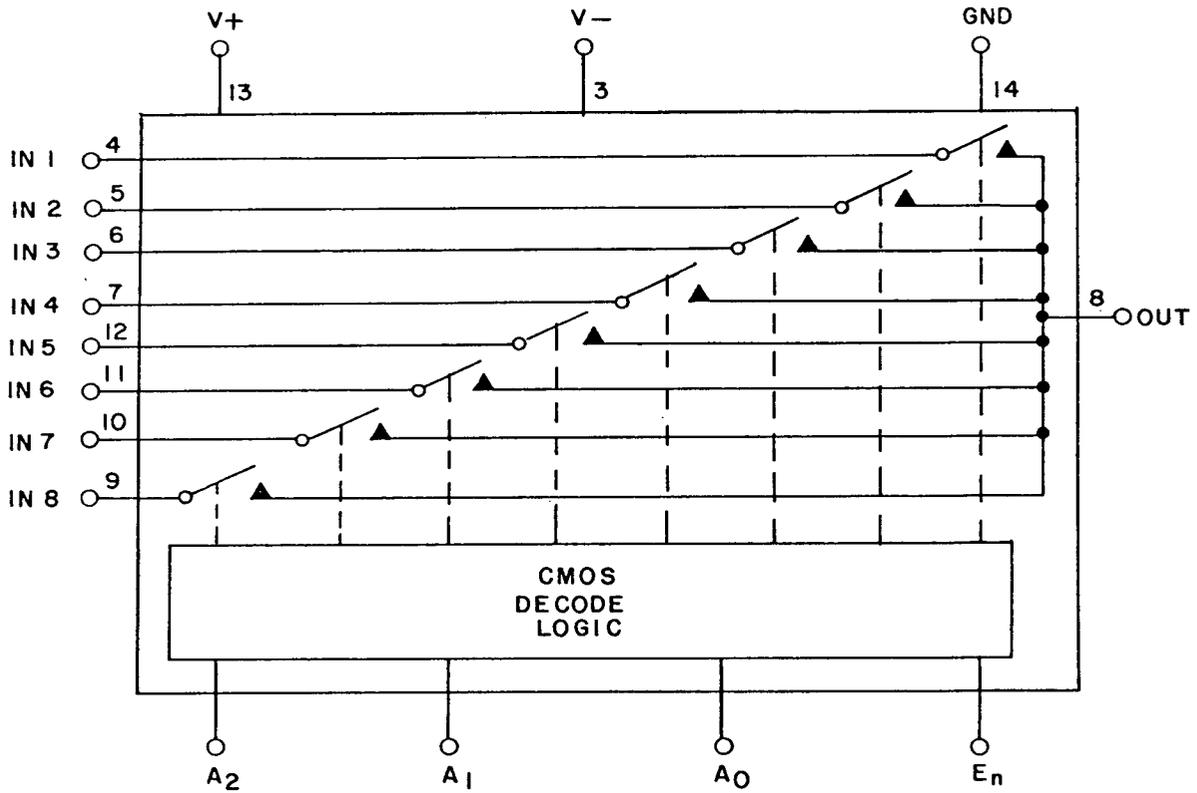


FIGURE 2. Functional diagrams - Continued.

Device types 05 and 07



Device types 06 and 08

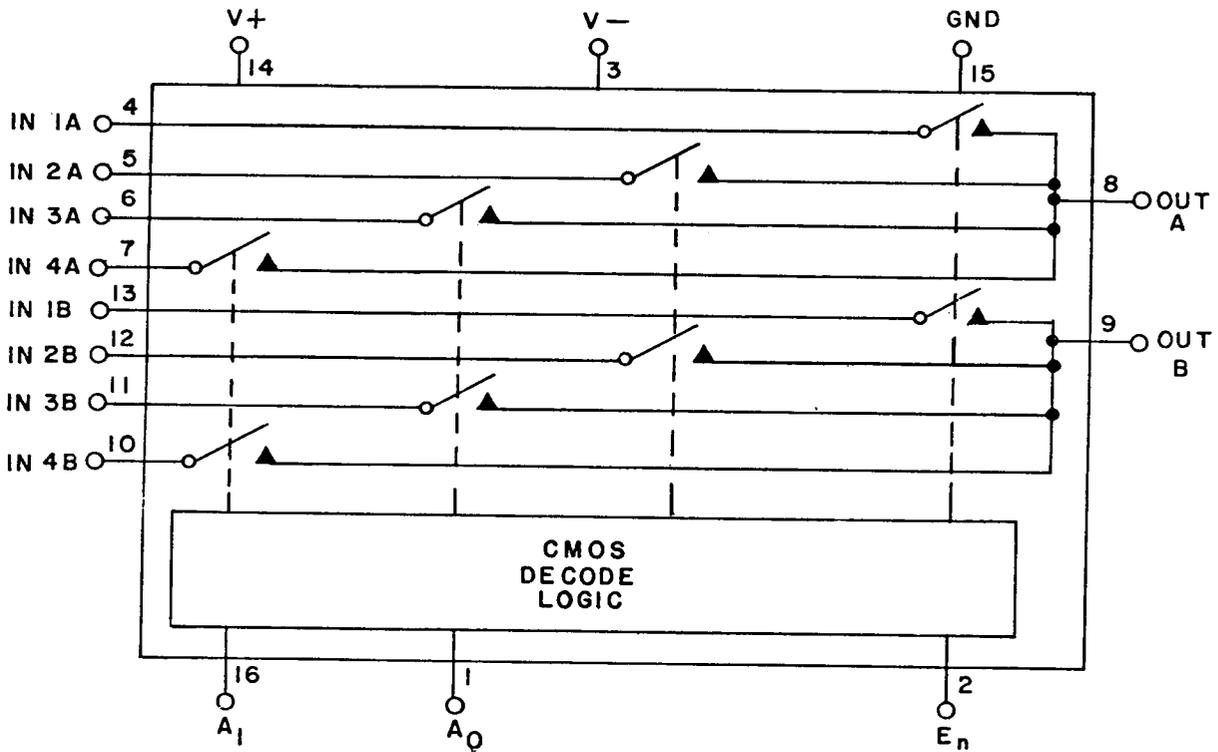


FIGURE 2. Functional diagrams - Continued.

Device types 01 and 02

A3	A2	A1	A0	EN	CHANNEL SELECTED
X	X	X	X	L	NONE
L	L	L	L	H	1
L	L	L	H	H	2
L	L	H	L	H	3
L	L	H	H	H	4
L	H	L	L	H	5
L	H	L	H	H	6
L	H	H	L	H	7
L	H	H	H	H	8
H	L	L	L	H	9
H	L	L	H	H	10
H	L	H	L	H	11
H	L	H	H	H	12
H	H	L	L	H	13
H	H	L	H	H	14
H	H	H	L	H	15
H	H	H	H	H	16

Device types 03 and 04

A2	A1	A0	EN	CHANNEL SELECTED
X	X	X	L	NONE
L	L	L	H	1A,1B
L	L	H	H	2A,2B
L	H	L	H	3A,3B
L	H	H	H	4A,4B
H	L	L	H	5A,5B
H	L	H	H	6A,6B
H	H	L	H	7A,7B
H	H	H	H	8A,8B

Device types 05 and 07

A2	A1	A0	EN	CHANNEL SELECTED
X	X	X	L	NONE
L	L	L	H	1
L	L	H	H	2
L	H	L	H	3
L	H	H	H	4
H	L	L	H	5
H	L	H	H	6
H	H	L	H	7
H	H	H	H	8

Device types 06 and 08

A1	A0	EN	CHANNEL SELECTED
X	X	L	NONE
L	L	H	1A,1B
L	H	H	2A,2B
H	L	H	3A,3B
H	H	H	4A,4B

FIGURE 3. Truth tables.

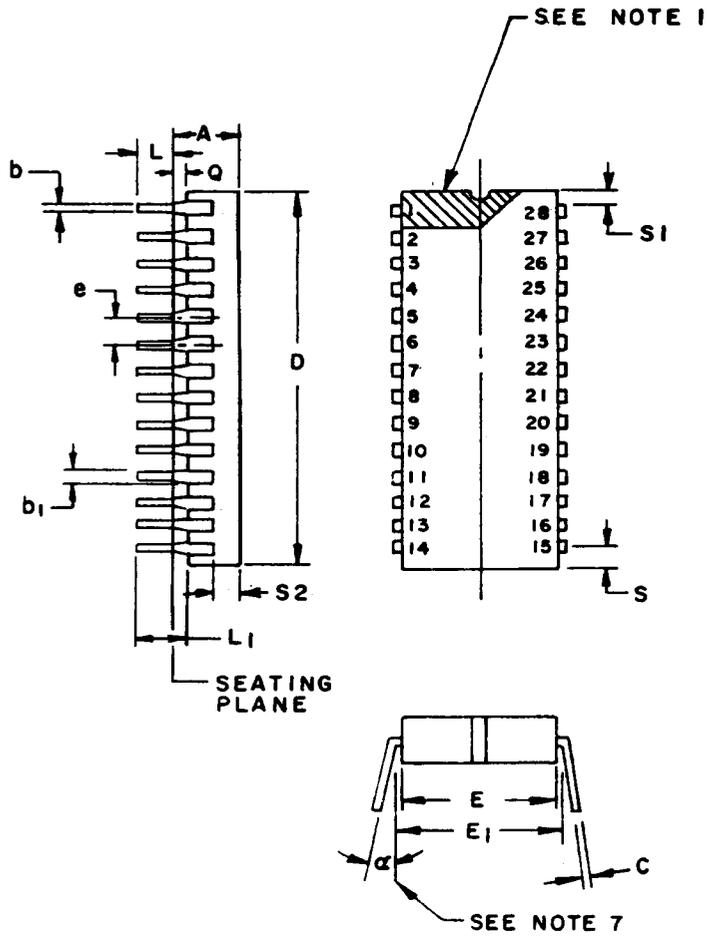


FIGURE 4. Case outline X (28-lead, 9/16" x 1-7/16").

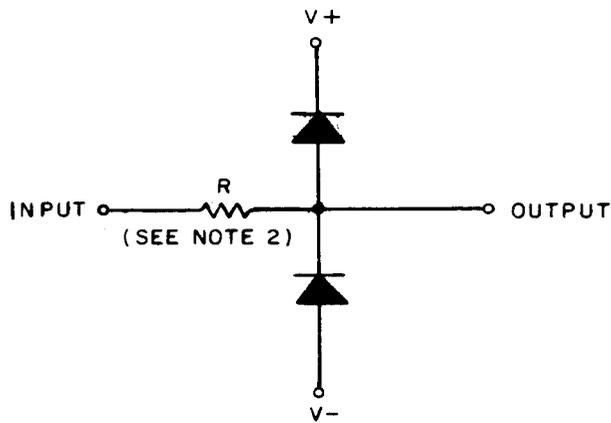
Symbol	Inches		Millimeters		Notes
	Min	Max	Min	Max	
A	---	.200	---	5.08	
b	.014	.023	0.36	0.58	8
b <sub>1</sub>	.040	.070	1.02	1.78	2,8
C	.008	.014	.20	0.36	8
D	---	1.48	---	37.6	4
E	.520	.610	13.21	13.97	4
E <sub>1</sub>	.585	.620	14.86	15.75	7
E <sub>2</sub>	N/A	N/A	N/A	N/A	
E <sub>3</sub>	N/A	N/A	N/A	N/A	
e	.100 BSC		2.54 BSC		5,9
L	.125	.200	3.18	5.08	
L <sub>1</sub>	.150		3.81	5.08	
Q	.015	.060	0.51	1.52	3
Q <sub>1</sub>	N/A	N/A	N/A	N/A	
S	---	.098	---	2.49	6
S <sub>1</sub>	.005	---	0.13	---	6
S <sub>2</sub>	.005	---	0.13	N/A	
α	0°	15°	0°	15°	

## NOTES:

1. Index area; a notch or a pin one identification mark shall be located adjacent to pin one and shall be located within the shaded area shown. The manufacturer's identification shall not be used as a pin one identification mark.
2. The minimum limit for dimension b<sub>1</sub> may be .023 (.58 mm) for leads number 1, 14, 15, and 28 only.
3. Dimension Q shall be measured from the seating plane to the base plane.
4. This dimension allows for off-center lid, meniscus and glass overrun.
5. The basic pin spacing is .100 (2.54 mm) between centerlines. Each pin centerline shall be located within ±.010 (.25 mm) of its exact longitudinal position relative to pins 1 and 28.
6. Applies to all four corners (leads number 1, 14, 15, and 28), and 40.5 appendix C of MIL-M-38510 shall apply.
7. Lead center when α=0°. E<sub>1</sub> shall be measured at the centerline of the leads (see 40.4 appendix C of MIL-M-38510).
8. All leads - Increase maximum limit by .003 (.08 mm) measured at the center of the flat, when lead finish A or B is applied.
9. Twenty six spaces.
10. If this configuration is used, no organic or polymeric materials shall be molded to the bottom of the package to cover the leads.

FIGURE 4. Case outline x (28-lead, 9/16" x 1-7/16") - Continued.

Network A

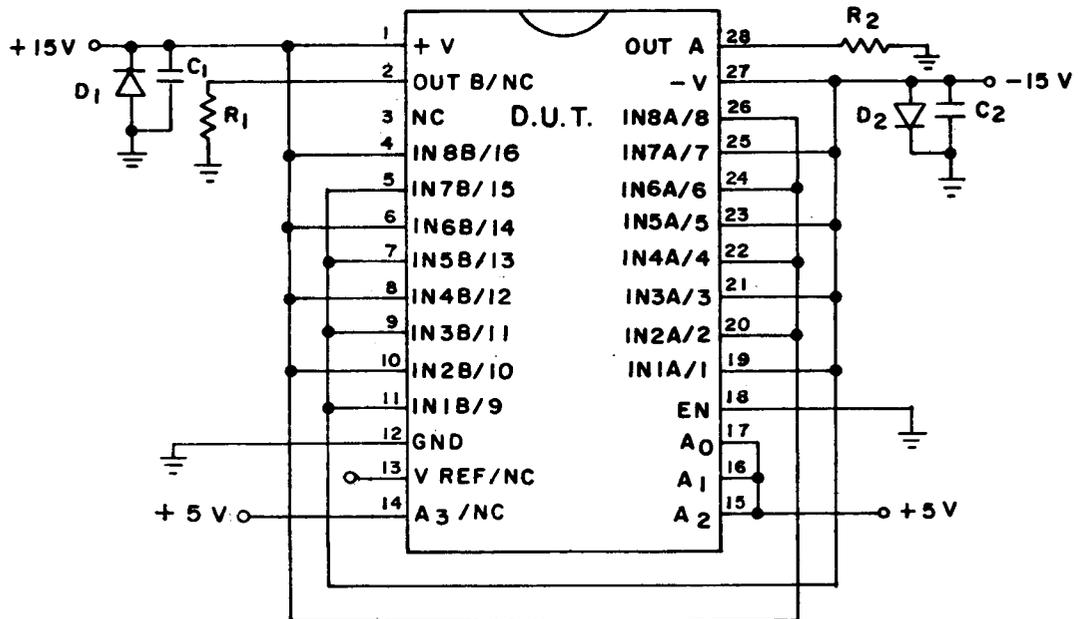


NOTES:

1. All device inputs shall be protected from transients such as electrostatic discharge. This circuit is intrinsic to the device.
2. This resistance is 200 to 2,000 ohms depending on device type.

FIGURE 5. Address and Enable input protection circuit for device types 02, 04, 05 and 06.

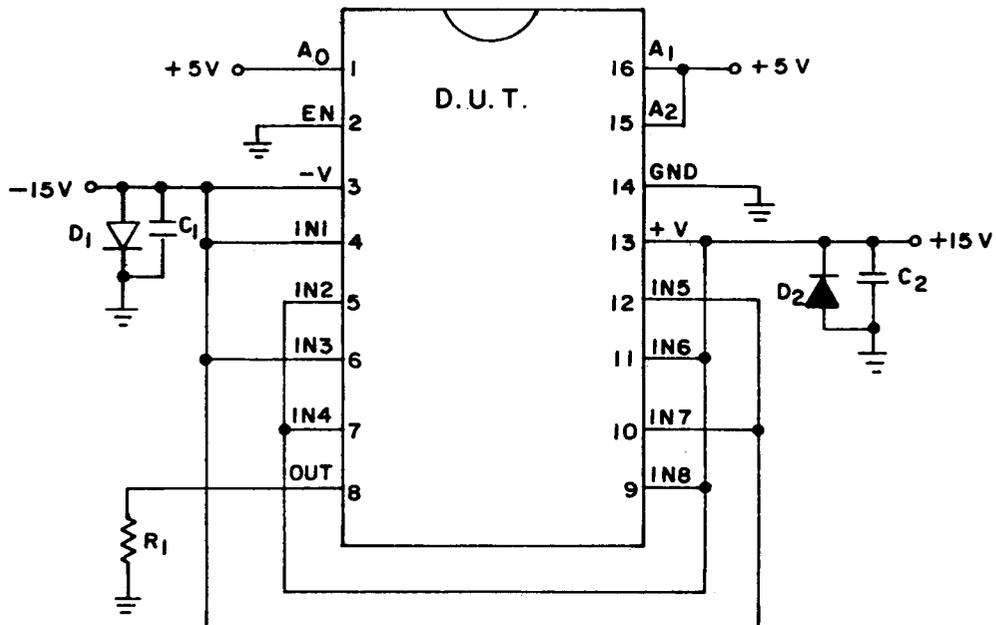
Device types 01, 02, 03, and 04



NOTE:  $R_1, R_2 = 10\text{ k}\Omega \pm 10\%$ , 1/2 or 1/4 W.  
 $C_1, C_2 = .01\ \mu\text{f}$ .  
 $D_1, D_2 = 1\text{N}4002$  (or equivalent).

FIGURE 6. Static burn-in test circuits.

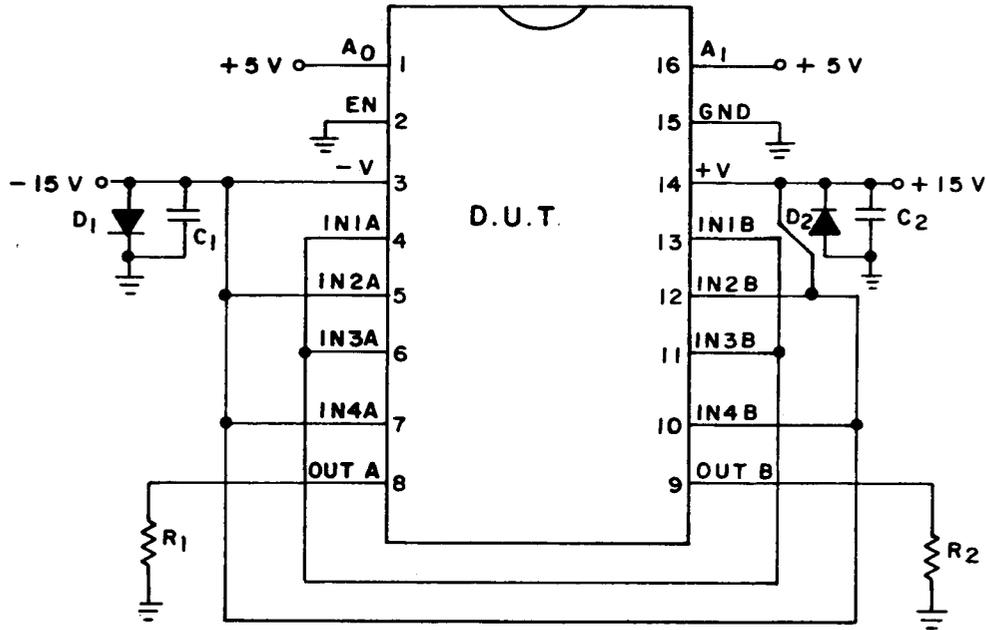
Device types 05 and 07



NOTE:  $R_1 = 10\text{ k}\Omega \pm 10\%$ , 1/4 or 1/2 W.  
 $C_1, C_2 = .01\ \mu\text{f}$ .  
 $D_1, D_2 = 1\text{N}4002$  (or equivalent).

FIGURE 6. Static burn-in test circuits - Continued.

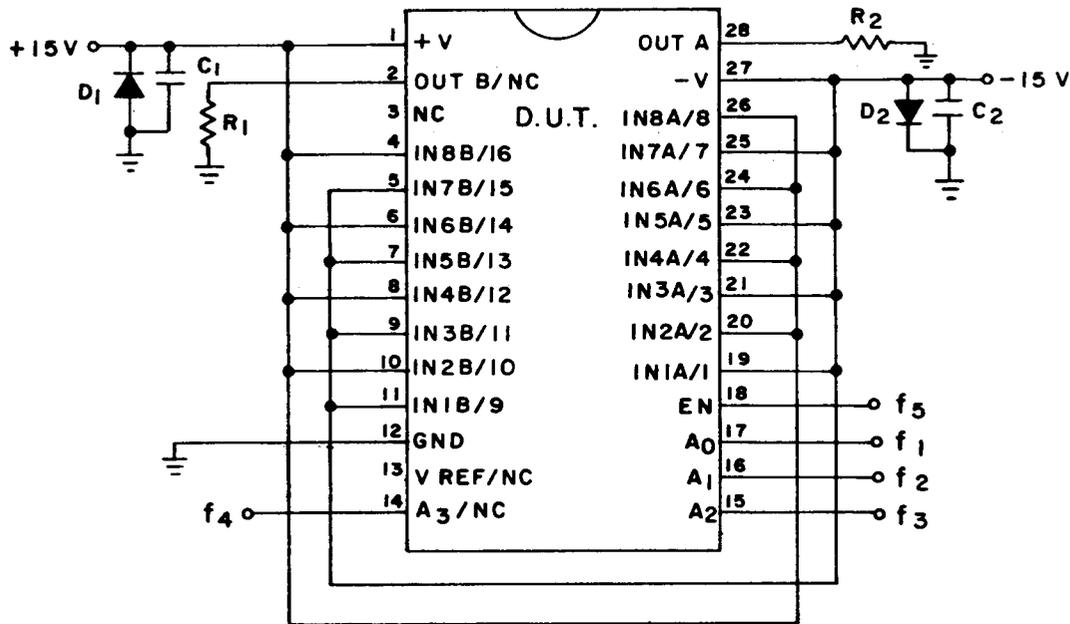
Device types 06 and 08



NOTE:  $R_1, R_2 = 10 \text{ k}\Omega \pm 10\%, 1/2 \text{ or } 1/4 \text{ W.}$   
 $C_1, C_2 = .01 \mu\text{f.}$   
 $D_1, D_2 = 1\text{N}4002 \text{ (or equivalent).}$

FIGURE 6. Static burn-in test circuits - Continued.

## Device types 01, 02, 03, and 04

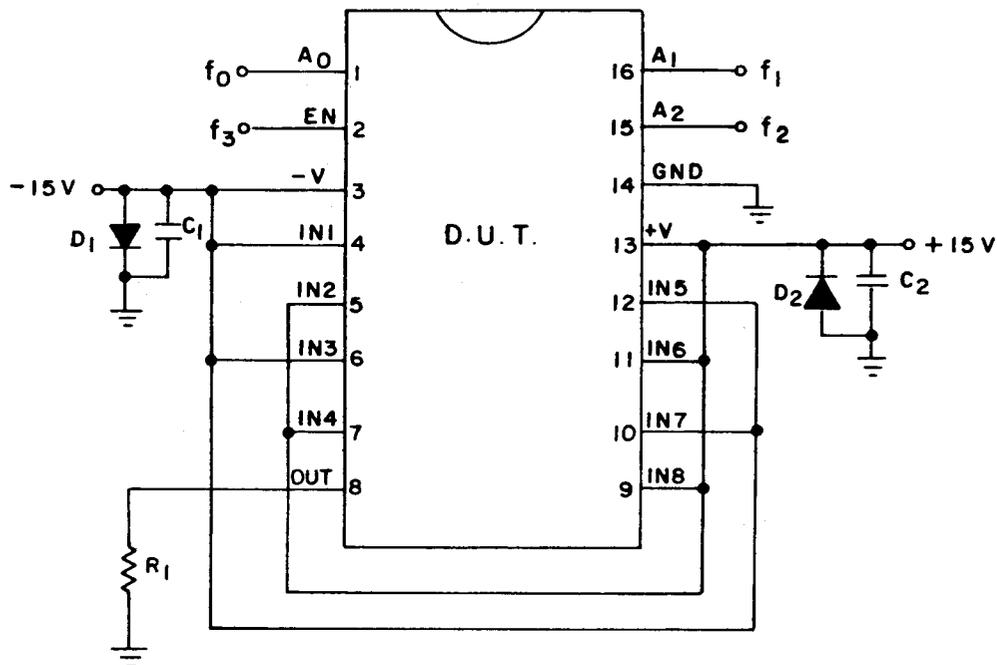


## NOTES:

1.  $R_1, R_2 = 10 \text{ k}\Omega \pm 10\%, 1/2 \text{ or } 1/4 \text{ W.}$   
 $C_1, C_2 = .01 \text{ }\mu\text{f.}$   
 $D_1, D_2 = 1\text{N}4002 \text{ (or equivalent).}$
2. Input signal requirements:
  - a. Square wave, 50% duty cycle.
  - b.  $f_1 = 100 \text{ kHz.}$   
 $f_2 = 50 \text{ kHz.}$   
 $f_3 = 25 \text{ kHz.}$   
 $f_4 = 12.5 \text{ kHz.}$   
 $f_5 = 6.25 \text{ kHz.}$
  - c.  $t_{TLH}$  and  $t_{THL} < 1 \text{ }\mu\text{s.}$
  - d. Voltage = 0 to 15 V peak minimum.

FIGURE 7. Dynamic and steady state life test circuits.

## Device types 05 and 07

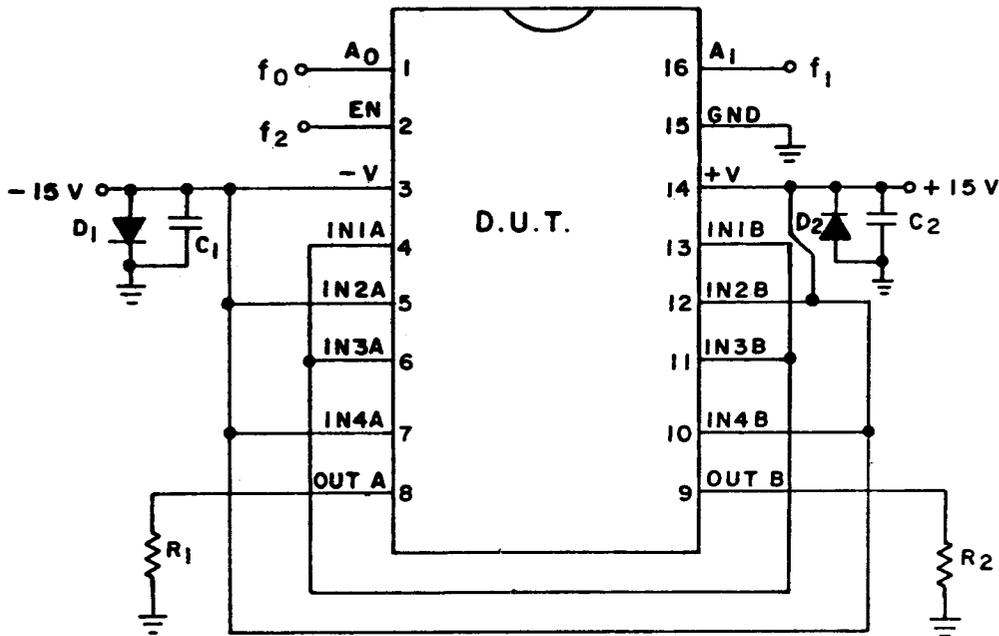


## NOTES:

1.  $R_1 = 10 \text{ k}\Omega \pm 10\%$ , 1/2 or 1/4 W.  
 $C_1, C_2 = .01 \text{ }\mu\text{f}$ .  
 $D_1, D_2 = 1\text{N}4002$  (or equivalent).
2. Input signal requirements:
  - a. Square wave, 50% duty cycle.
  - b.  $f_0 = 100 \text{ kHz}$ .  
 $f_1 = 50 \text{ kHz}$ .  
 $f_2 = 25 \text{ kHz}$ .  
 $f_3 = 12.5 \text{ kHz}$ .
  - c.  $t_{\text{TLH}}$  and  $t_{\text{THL}} < 1 \text{ }\mu\text{s}$ .
  - d. Voltage = 0 to 15 V peak minimum.

FIGURE 7. Dynamic and steady state life test circuits - Continued.

Device types 06 and 08

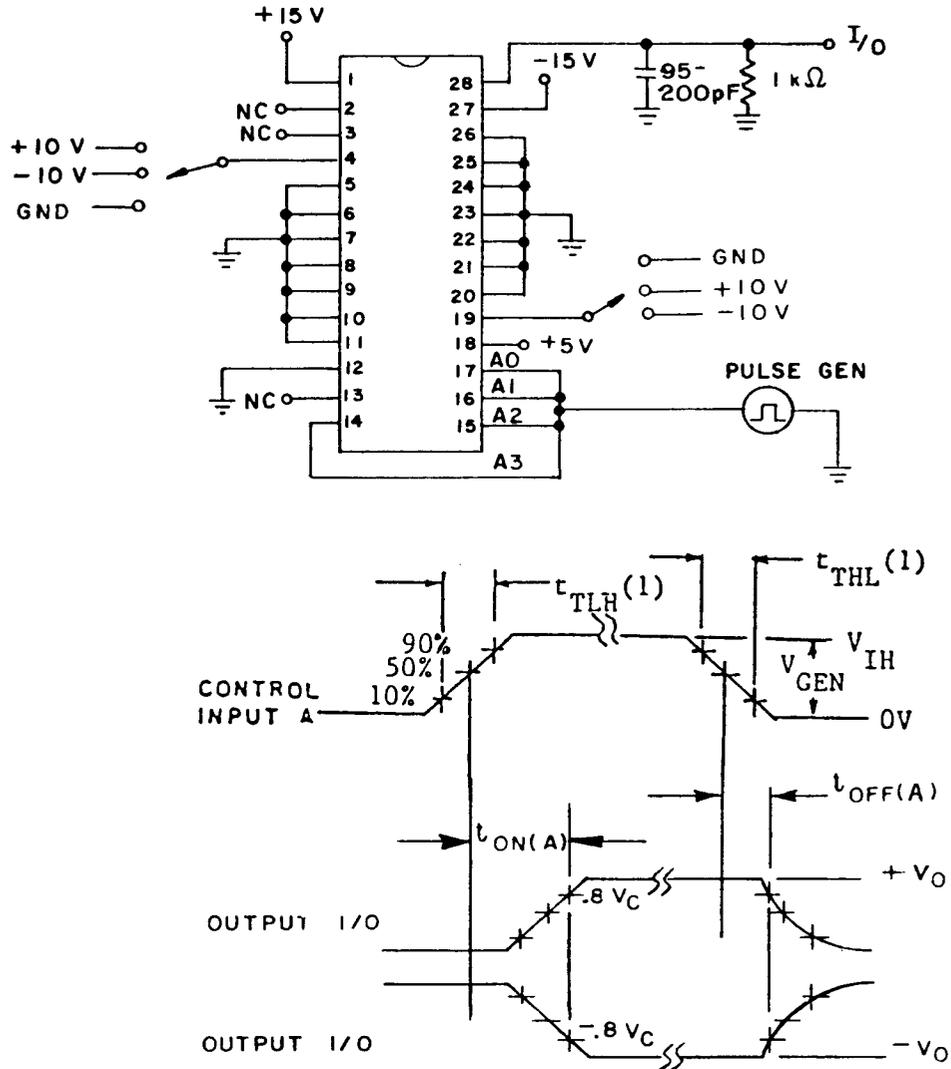


## NOTES:

1.  $R_1, R_2 = 10 \text{ k}\Omega \pm 10\%$ , 1/2 or 1/4 W.  
 $C_1, C_2 = .01 \mu\text{f}$ .  
 $D_1, D_2 = 1\text{N}4002$  (or equivalent).
2. Input signal requirements:
  - a. Square wave, 50% duty cycle.
  - b.  $f_0 = 100 \text{ kHz}$ .  
 $f_1 = 50 \text{ kHz}$ .  
 $f_2 = 25 \text{ kHz}$ .
  - c.  $t_{\text{TLH}}$  and  $t_{\text{THL}} = 1 \mu\text{s}$ .
  - d. Voltage = 0 to 15 V peak minimum.

FIGURE 7. Dynamic and steady state life test circuits - Continued.

Device types 01 and 02

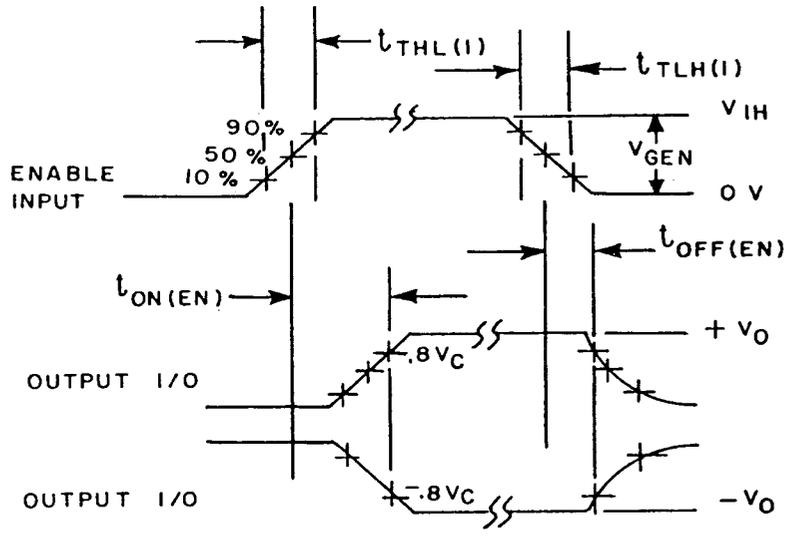
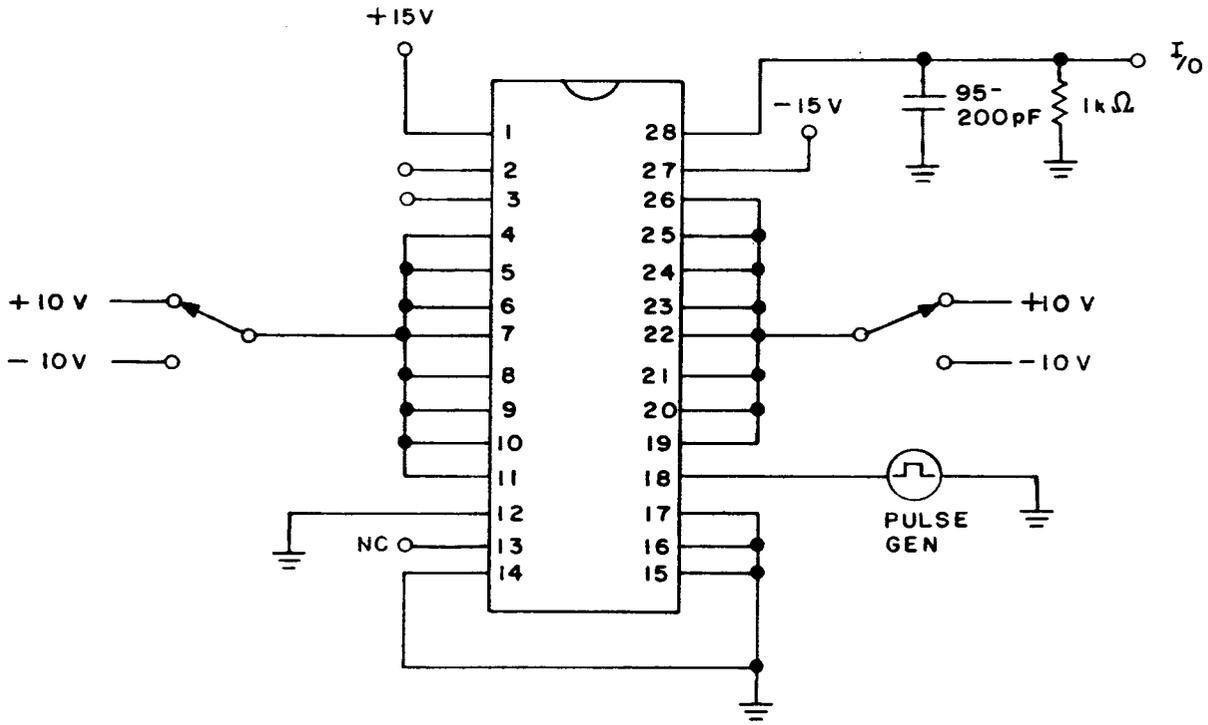


Input pulse requirements:  
 $V_{GEN} = 4V$   
 $t_{THL(1)} = t_{TLH(1)} \leq 20 \text{ ns.}$

DYNAMIC TEST WAVEFORMS

FIGURE 8. Switching times test circuit and waveforms.  
 (Address inputs to I/O)

Device types 01 and 02

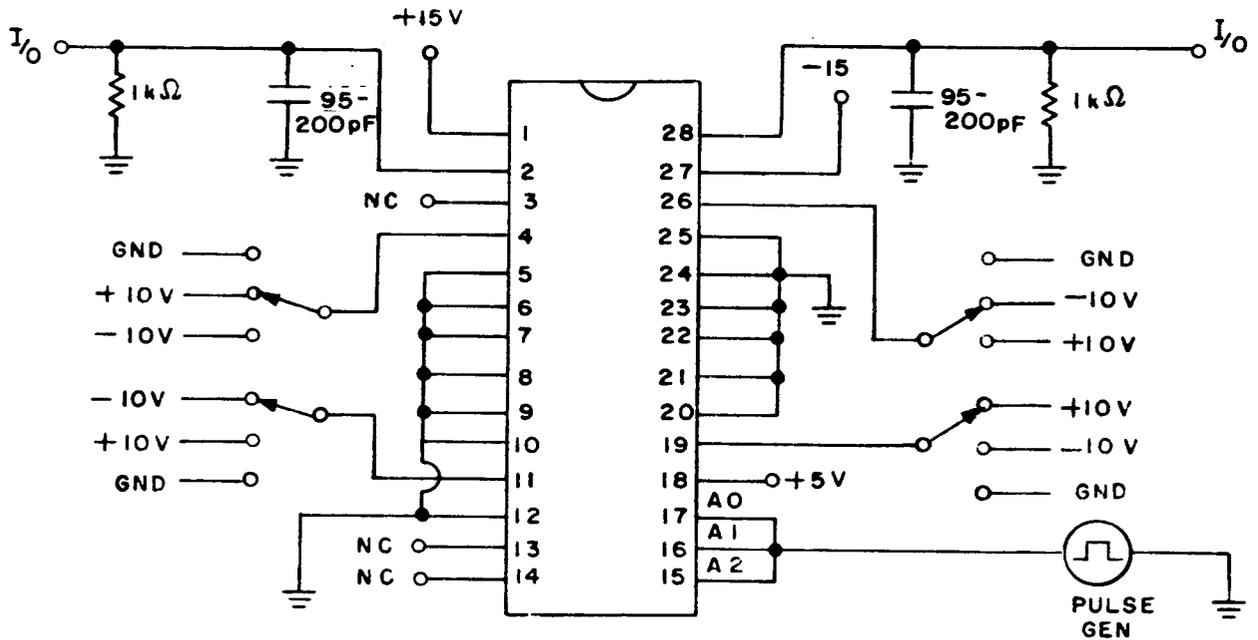


Input pulse requirements:  
 $V_{GEN} = 4 \text{ V.}$   
 $t_{THL(1)} = t_{TLH(1)} \leq 20 \text{ ns.}$

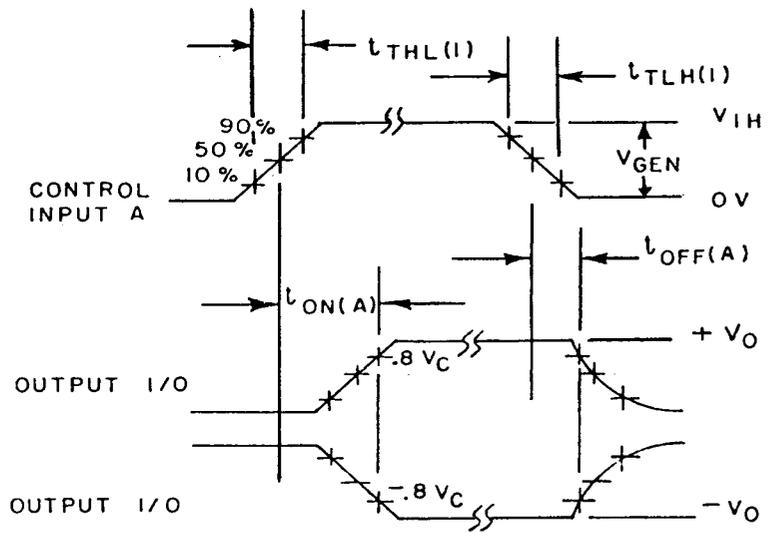
DYNAMIC TEST WAVEFORMS

FIGURE 9. Switching times test circuit and waveforms.  
 (Enable to I/O)

Device types 03 and 04



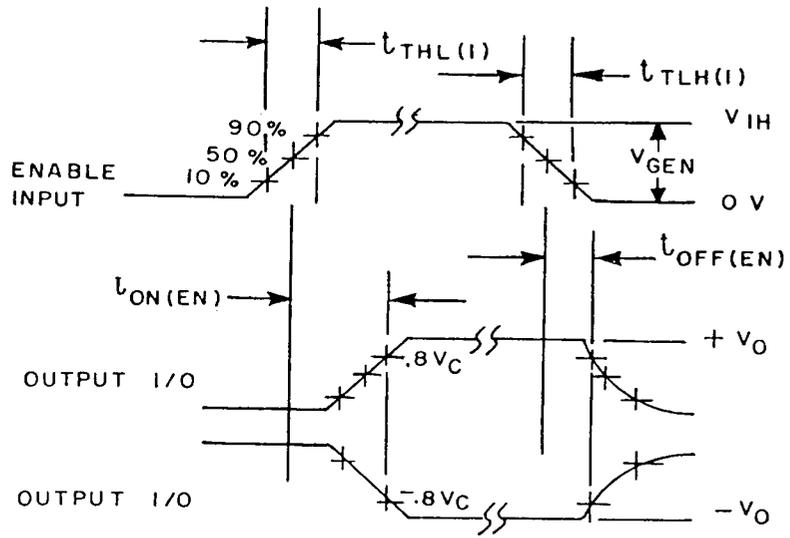
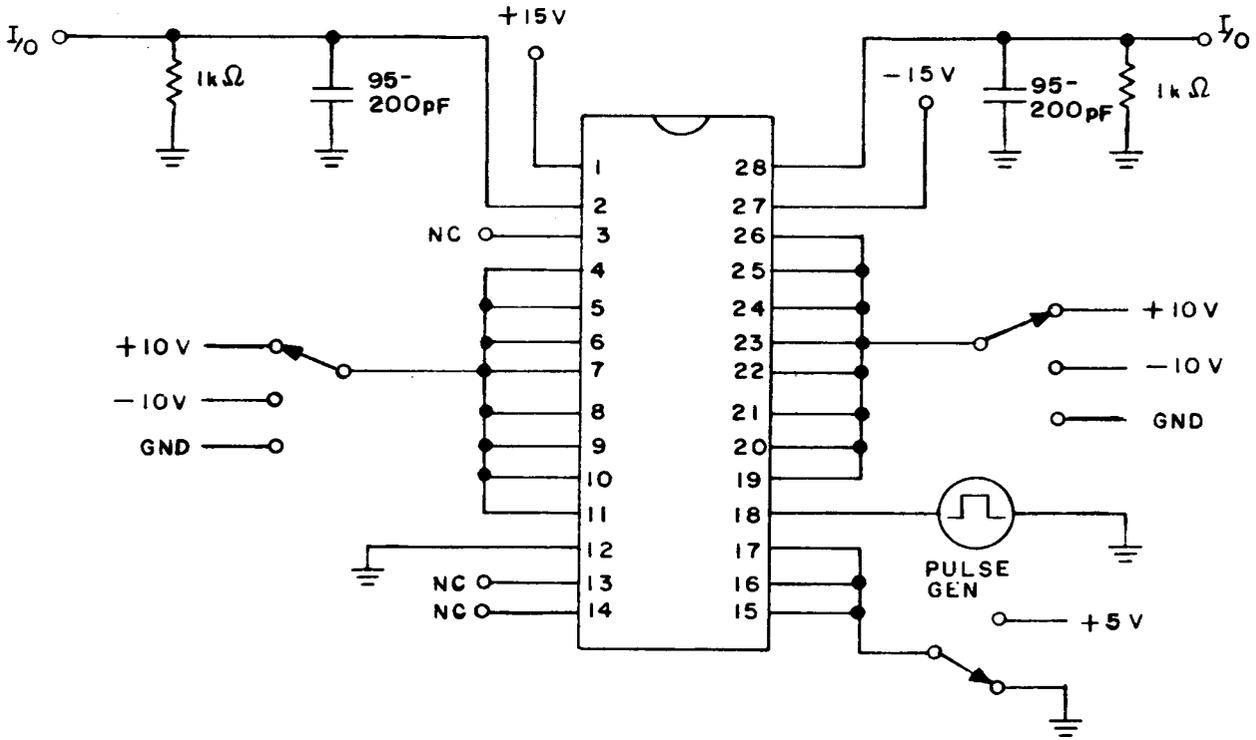
Input pulse requirements:  
 $V_{GEN} = 4 \text{ V.}$   
 $t_{THL(1)} = t_{TLH(1)} \leq 20 \text{ ns.}$



DYNAMIC TEST WAVEFORMS

FIGURE 10. Switching times test circuit and waveforms.  
 (Address inputs to I/O)

Device types 03 and 04



Input pulse requirements:  
 $V_{GEN} = 4 \text{ V.}$   
 $t_{THL(1)} = t_{TLH(1)} \leq 20 \text{ ns.}$

DYNAMIC TEST WAVEFORMS

FIGURE 11. Switching times test circuit and waveforms.  
 (Enable to I/O)

Device types 05 and 07

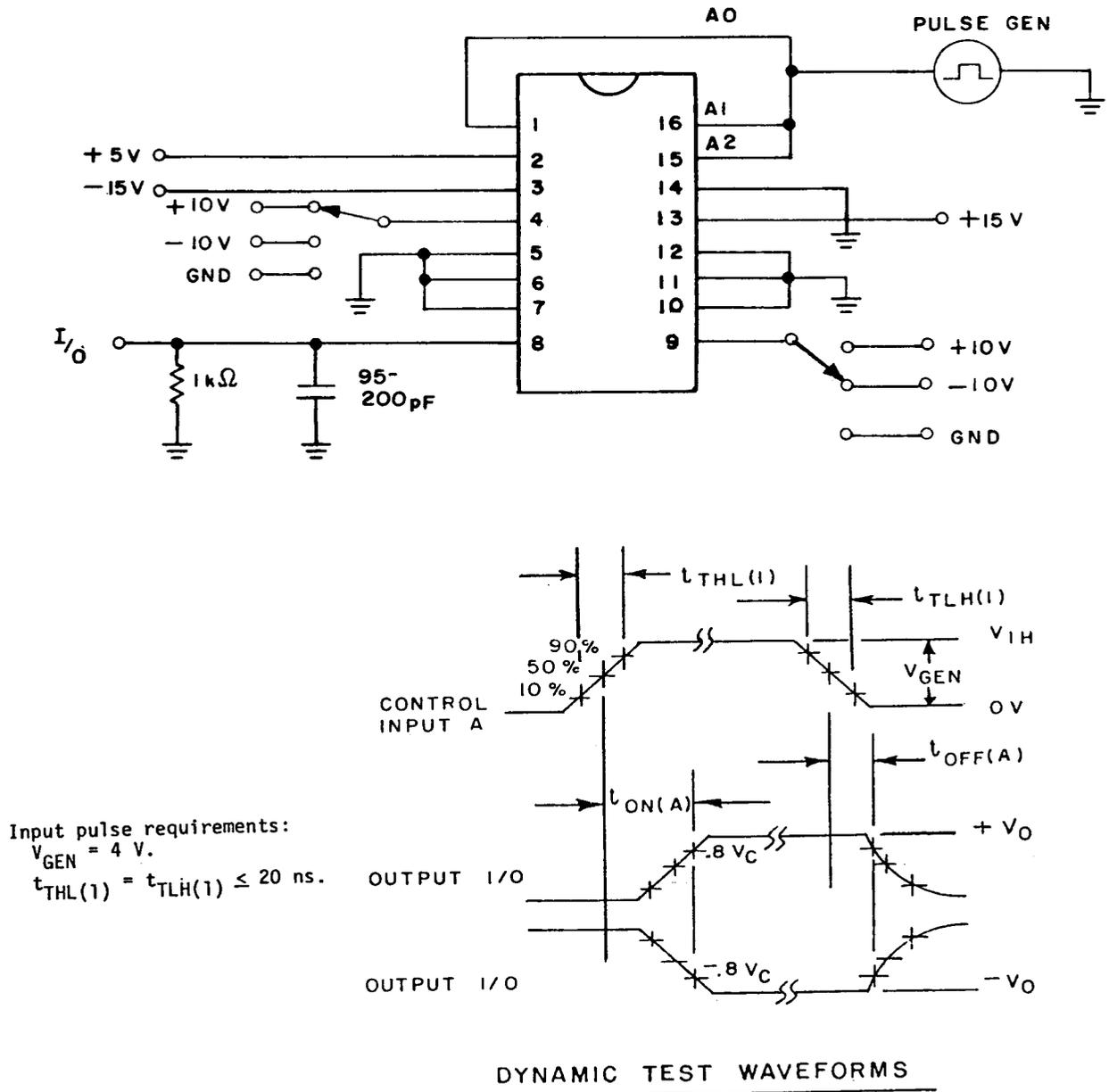
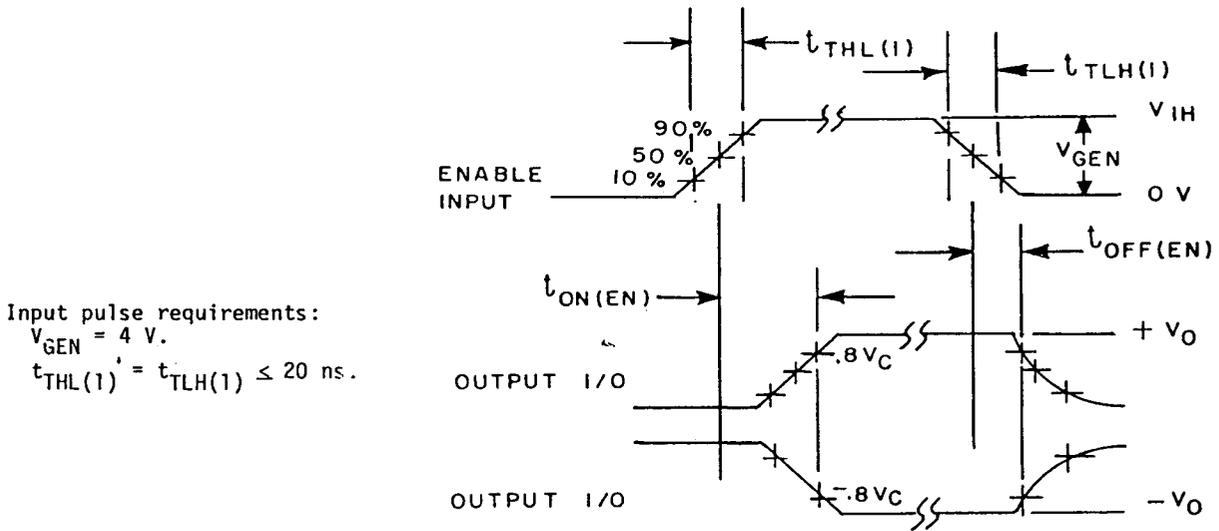
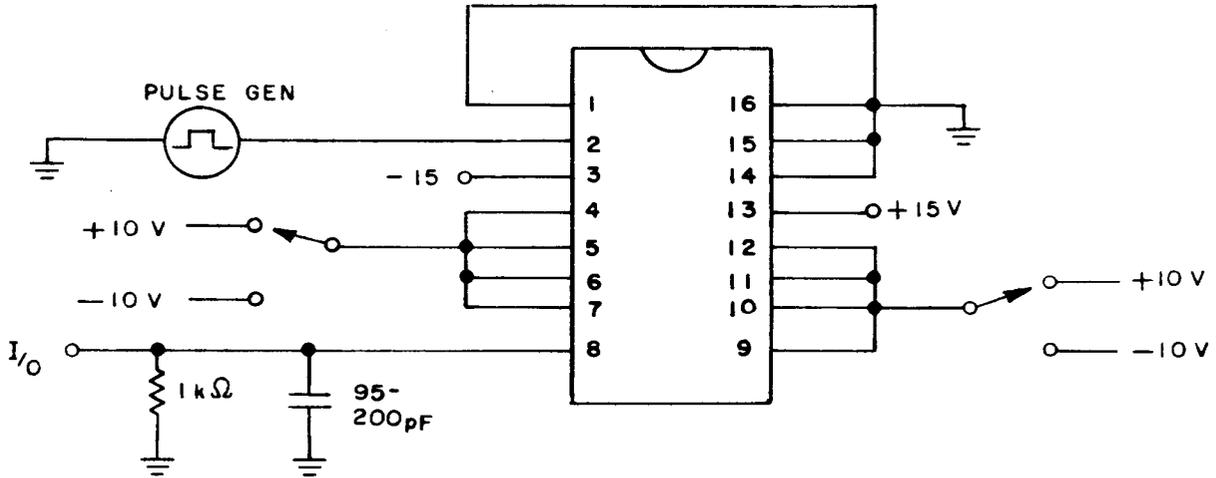


FIGURE 12. Switching times test circuit and waveforms.  
 (Address inputs to I/O)

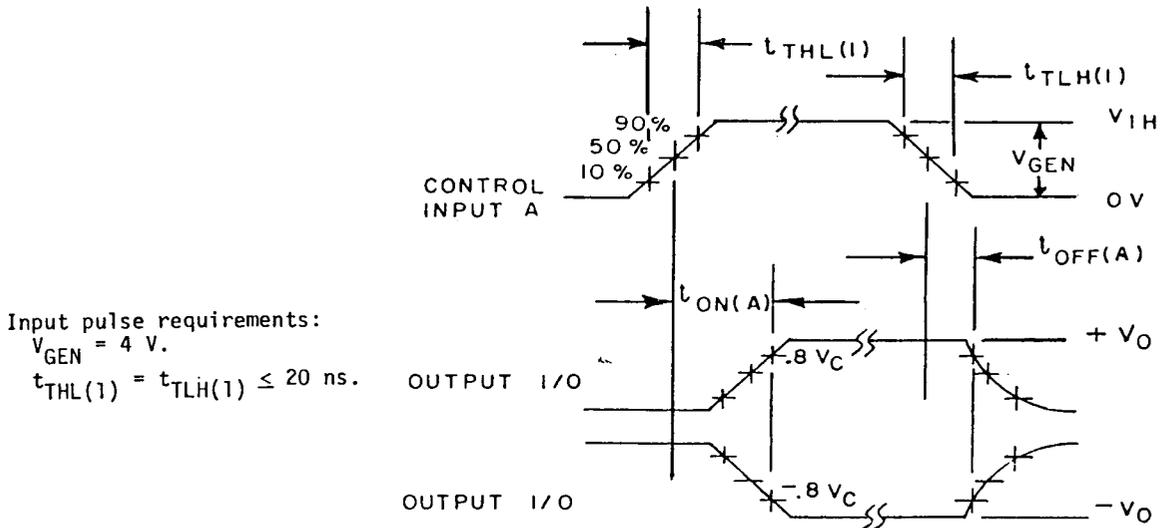
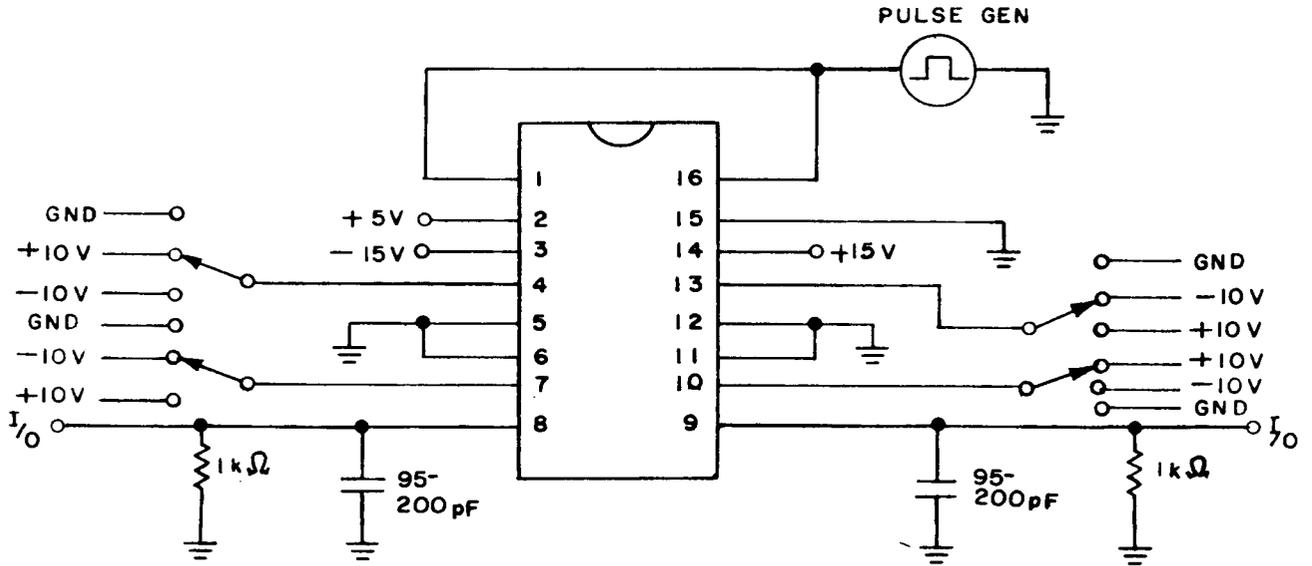
Device types 05 and 07



DYNAMIC TEST WAVEFORMS

FIGURE 13. Switching times test circuit and waveforms.  
 (Enable to I/O)

Device types 06 and 08



DYNAMIC TEST WAVEFORMS

FIGURE 14. Switching times test circuit and waveforms.  
 (Address inputs to I/O)

Device types 06 and 08

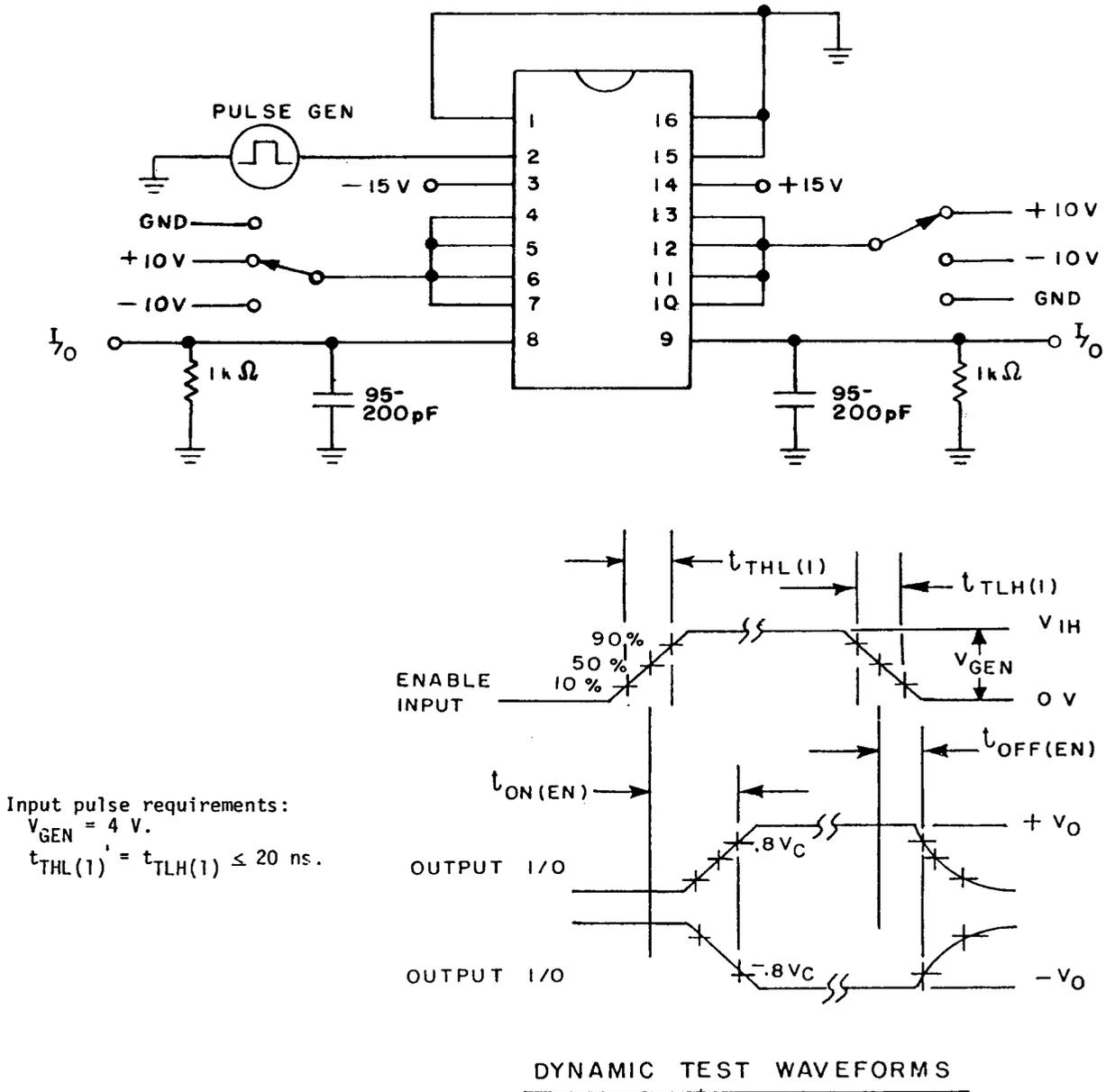


FIGURE 15. Switching times test circuit and waveforms.  
 (Enable to I/O)

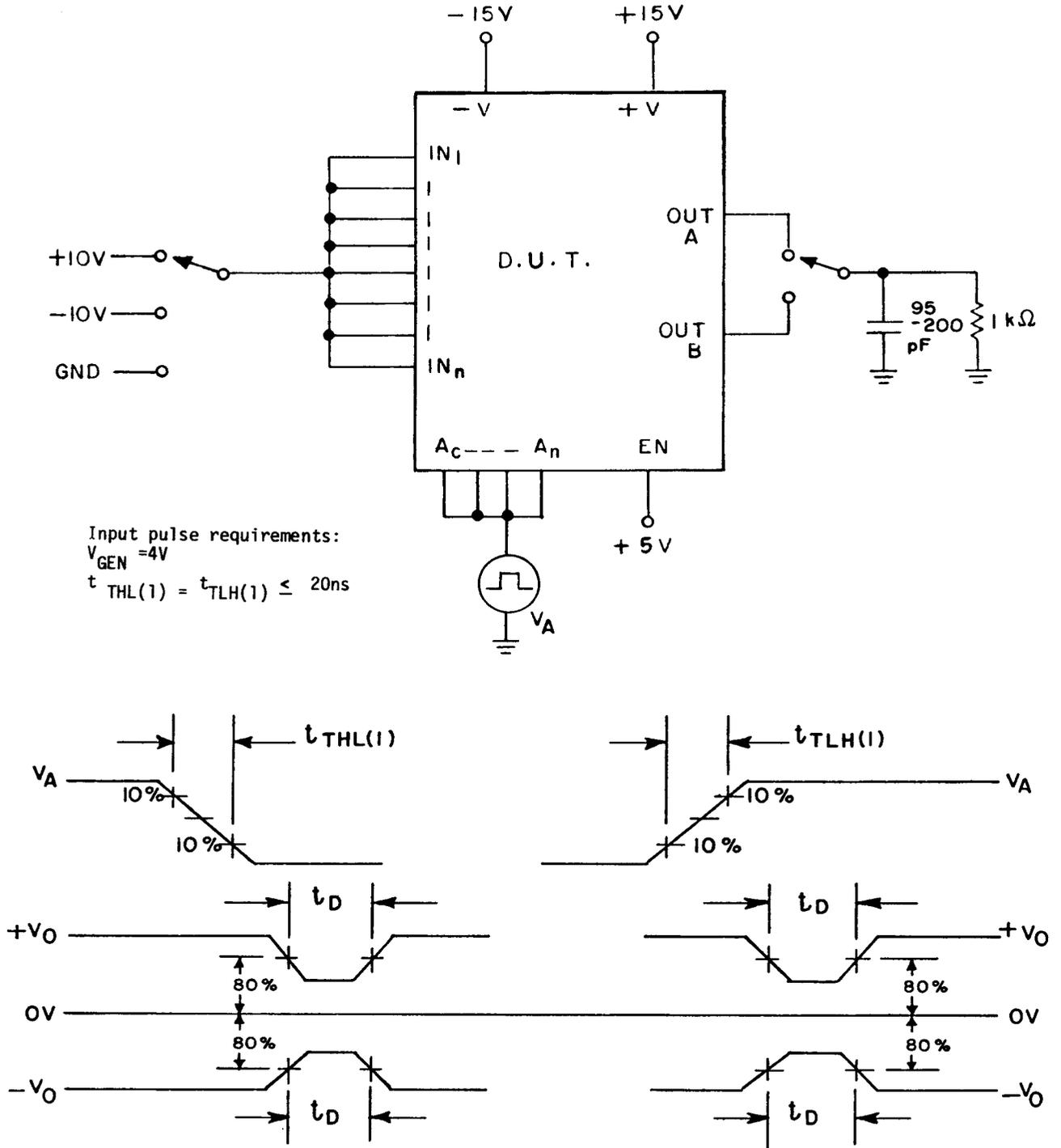


FIGURE 16. Break before make test circuit and waveforms.

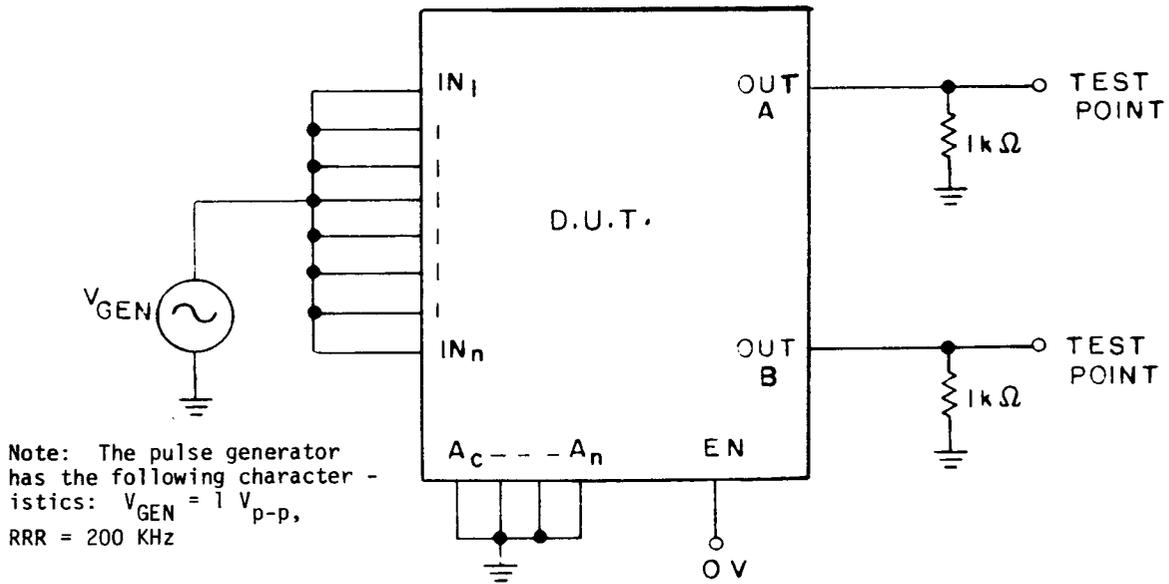
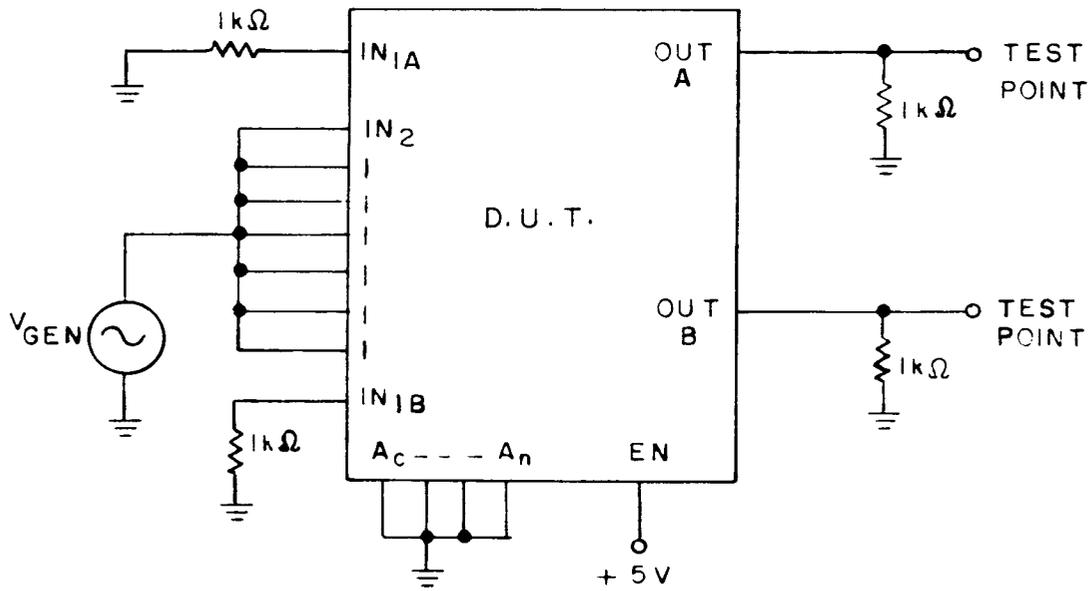
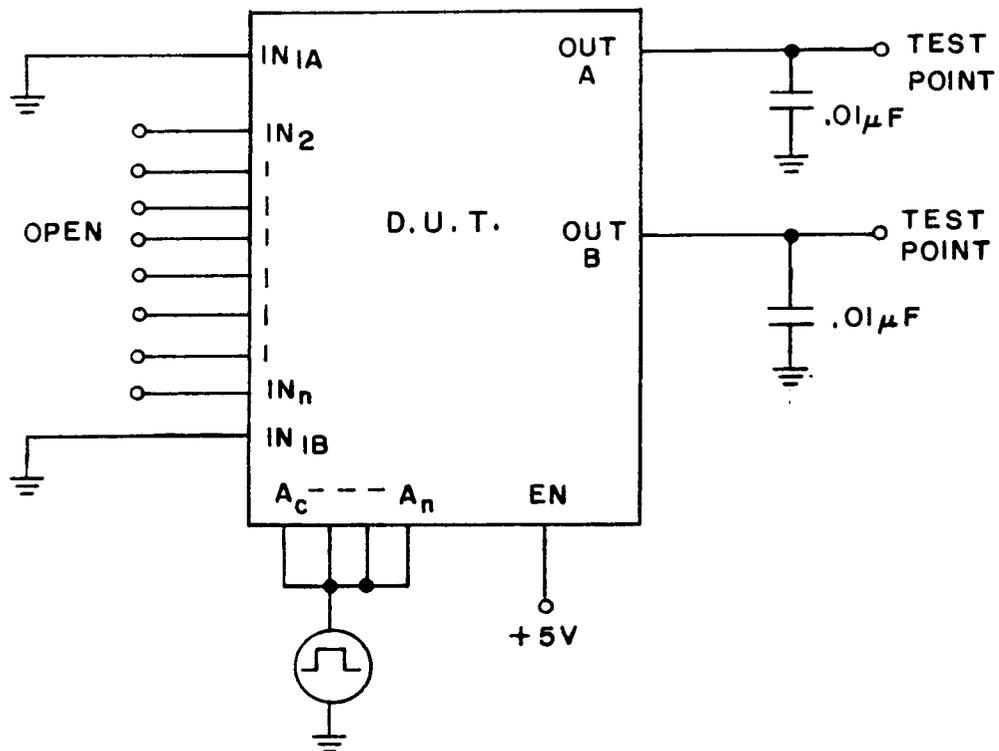


FIGURE 17. Single channel isolation test circuit.



Note: The pulse generator has the following characteristics:  $V_{GEN} = 1V_{p-p}$ ;  $PRR = 200\text{KHz}$ .

FIGURE 18. Crosstalk test circuit.



NOTE: The pulse generator has the following characteristics:  
 $V_{GEN} = 0 - 5V$

FIGURE 19. Charge transfer error test circuit.

TABLE III. Group A inspection for device type 01.

Symbol	MIL-STD-883 method	Case X	Terminal conditions 1/																Measured terminal	Test limits						Unit
																				Subgroup 1 T <sub>A</sub> = 25°C		Subgroup 2 T <sub>A</sub> = 125°C		Subgroup 3 T <sub>A</sub> = -55°C		
			1	2	3	4	5	6	7	8	9	10	11	12	13	14	Min	Max		Min	Max	Min	Max			
I <sub>IH</sub> 2/	3010	1	V+	NC	NC	IN16	IN15	IN14	IN13	IN12	IN11	IN10	IN9	GND	NC	A3	2.4 V	A3	-0.1	1.0	-0.1	1.0	-0.1	1.0	μA	
	"	2	"	"	"	"	"	"	"	"	"	"	"	"	"	"	GND	A2	"	"	"	"	"	"	"	
	"	3	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	A1	"	"	"	"	"	"	"	
	"	4	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	A0	"	"	"	"	"	"	"	
	"	5	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	EN	"	"	"	"	"	"	"	
I <sub>IL</sub> 2/	3009	6	"	"	"	"	"	"	"	"	"	"	"	"	"	"	0.8 V	A3	-1.0	0.1	-1.0	0.1	-1.0	0.1	"	
	"	7	"	"	"	"	"	"	"	"	"	"	"	"	"	"	5 V	A2	"	"	"	"	"	"	"	
	"	8	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	A1	"	"	"	"	"	"	"	
	"	9	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	A0	"	"	"	"	"	"	"	
	"	10	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	EN	"	"	"	"	"	"	"	
I <sub>S</sub> (OFF) 2/		11	"	"	"	"	"	"	"	"	"	"	"	"	"	"	0.8 V	IN1	-1	1	-50	50	-50	50	nA	
		12	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN2	"	"	"	"	"	"	"	
		13	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN3	"	"	"	"	"	"	"	
		14	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN4	"	"	"	"	"	"	"	
		15	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN5	"	"	"	"	"	"	"	
		16	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN6	"	"	"	"	"	"	"	
		17	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN7	"	"	"	"	"	"	"	
		18	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN8	"	"	"	"	"	"	"	
		19	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN9	"	"	"	"	"	"	"	
		20	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN10	"	"	"	"	"	"	"	
		21	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN11	"	"	"	"	"	"	"	
		22	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN12	"	"	"	"	"	"	"	
		23	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN13	"	"	"	"	"	"	"	
		24	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN14	"	"	"	"	"	"	"	
		25	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN15	"	"	"	"	"	"	"	
		26	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN16	"	"	"	"	"	"	"	
		27	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN1	"	"	"	"	"	"	"	
		28	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN2	"	"	"	"	"	"	"	
		29	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN3	"	"	"	"	"	"	"	
		30	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN4	"	"	"	"	"	"	"	
		31	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN5	"	"	"	"	"	"	"	
		32	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN6	"	"	"	"	"	"	"	
		33	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN7	"	"	"	"	"	"	"	
		34	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN8	"	"	"	"	"	"	"	
		35	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN9	"	"	"	"	"	"	"	
		36	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN10	"	"	"	"	"	"	"	
		37	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN11	"	"	"	"	"	"	"	
		38	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN12	"	"	"	"	"	"	"	
		39	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN13	"	"	"	"	"	"	"	
		40	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN14	"	"	"	"	"	"	"	
		41	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN15	"	"	"	"	"	"	"	
		42	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN16	"	"	"	"	"	"	"	
I <sub>D</sub> -(OFF)		43	"	"	"	"	"	"	"	"	"	"	"	"	"	"	0.8 V	OUT	-20	20	-500	500	-500	500	"	
I <sub>D</sub> *(OFF)		44	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	OUT	"	"	"	"	"	"	"	
I <sub>D</sub> *(ON)		45	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN1 & OUT	"	"	"	"	"	"	"	
		46	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN2 & OUT	"	"	"	"	"	"	"	
		47	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN3 & OUT	"	"	"	"	"	"	"	
		48	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN4 & OUT	"	"	"	"	"	"	"	
		49	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN5 & OUT	"	"	"	"	"	"	"	
		50	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN6 & OUT	"	"	"	"	"	"	"	
		51	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN7 & OUT	"	"	"	"	"	"	"	

See footnotes at end of table.



TABLE III. Group A inspection for device type 01 - Continued.

Symbol	MIL-STD-883 method	Case X	Terminal conditions I/														Test limits						Unit
			Terminal conditions I/														Subgroup 1 T <sub>A</sub> = 25°C		Subgroup 2 T <sub>A</sub> = 125°C		Subgroup 3 T <sub>A</sub> = -55°C		
			1	2	3	4	5	6	7	8	9	10	11	12	13	14	Min	Max	Min	Max	Min	Max	
		Test no.	V+	NC	NC	IN16	IN15	IN14	IN13	IN12	IN11	IN10	IN9	GND	NC	A3							
I <sub>D+</sub> (ON)		52	15 V			-10 V	GND		0.8 V	-20	-500	500	-500	500	nA								
		53	"			-10 V			2.4 V	"	"	"	"	"	"								
		54	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		55	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		56	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		57	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		58	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		59	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		60	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
I <sub>D-</sub> (ON)		61	"			10 V			0.8 V	"	"	"	"	"	"								
		62	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		63	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		64	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		65	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		66	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		67	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		68	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		69	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		70	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		71	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		72	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		73	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		74	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		75	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		76	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
I+		77	"			"	"	"	"	"	"	"	"			0 V	14	14	14	-4.0	14	14 mA	
I-		78	"			"	"	"	"	"	"	"	"			"	-14	-14	-14	-14	-14	"	
I+SBY		79	"			"	"	"	"	"	"	"	"			"	3.0	3.0	3.0	3.0	3.0	"	
I-SBY		80	"			"	"	"	"	"	"	"	"			"	-4.0	-4.0	-4.0	-4.0	-4.0	"	
R <sub>DS1</sub>		81	"			"	"	"	"	"	"	"	"			"	600	600	600	600	600	Ω	
		82	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		83	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		84	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		85	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		86	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		87	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		88	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		89	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		90	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		91	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		92	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		93	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		94	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		95	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		96	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		97	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		98	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		99	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		100	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	
		101	"			"	"	"	"	"	"	"	"			"	"	"	"	"	"	"	

See footnotes at end of table.

TABLE III. Group A inspection for device type 01 - Continued.

Symbol	Case X Test no.	terminal conditions																	Measured terminal	Test limits						Unit							
		I																		Subgroup 1 TA = 25 °C		Subgroup 2 TA = 125 °C		Subgroup 3 TA = -55 °C									
		15	16	17	18	19	20	21	22	23	24	25	26	27	28	Min	Max	Min		Max	Min	Max											
I <sub>D+</sub> (ON)	52	2.4 V	2.4 V	2.4 V	4.5 V	-10 V	10 V	10 V	10 V	10 V	10 V	10 V	IN8 & OUT	-20	20	-500	500	-500	500	500	µA												
	53	0.8 V	0.8 V	0.8 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN9 & OUT	"	"	"	"	"	"	"	"			
	54	0.8 V	0.8 V	0.8 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN10 & OUT	"	"	"	"	"	"	"	"	"		
	55	"	2.4 V	0.8 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN11 & OUT	"	"	"	"	"	"	"	"	"		
	56	"	2.4 V	0.8 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN12 & OUT	"	"	"	"	"	"	"	"	"	"	
	57	2.4 V	0.8 V	0.8 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN13 & OUT	"	"	"	"	"	"	"	"	"	"	
I <sub>D-</sub> (ON)	61	0.8 V	0.8 V	0.8 V	"	-10 V	10 V	10 V	10 V	10 V	10 V	10 V	10 V	10 V	10 V	10 V	10 V	10 V	10 V	10 V	10 V	IN1 & OUT	"	"	"	"	"	"	"	"	"		
	62	"	0.8 V	2.4 V	"	10 V	10 V	10 V	IN2 & OUT	"	"	"	"	"	"	"	"	"															
	63	"	2.4 V	0.8 V	"	10 V	10 V	10 V	IN3 & OUT	"	"	"	"	"	"	"	"	"															
	64	"	2.4 V	2.4 V	"	"	-10 V	-10 V	-10 V	-10 V	IN4 & OUT	"	"	"	"	"	"	"	"	"													
	65	2.4 V	0.8 V	0.8 V	"	"	10 V	10 V	10 V	10 V	IN5 & OUT	"	"	"	"	"	"	"	"	"													
	66	"	0.8 V	0.8 V	"	"	"	"	-10 V	-10 V	-10 V	-10 V	IN6 & OUT	"	"	"	"	"	"	"	"	"											
I <sub>T+</sub>	77	0 V	0 V	0 V	5 V	5 V	5 V	5 V	5 V	5 V	5 V	5 V	5 V	5 V	5 V	5 V	5 V	5 V	5 V	5 V	5 V	V+	14	14	14	14	14	14	14	14	14	mA	
	78	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	V-	-14	-14	-14	-14	-14	-14	-14	-14	-14	"	
	79	"	"	"	0 V	0 V	0 V	0 V	0 V	0 V	0 V	0 V	0 V	0 V	0 V	0 V	0 V	0 V	0 V	0 V	0 V	V+	3.0	3.0	3.0	3.0	3.0	3.0	3.0	3.0	3.0	"	
	80	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	V-	-4.0	-4.0	-4.0	-4.0	-4.0	-4.0	-4.0	-4.0	-4.0	"	
	R <sub>DS1</sub>	81	0.8 V	0.8 V	0.8 V	4.5 V	10 V	10 V	10 V	10 V	10 V	10 V	10 V	10 V	10 V	10 V	10 V	10 V	10 V	10 V	10 V	10 V	IN1 & OUT	600	600	600	600	600	600	600	600	600	Ω
		82	"	0.8 V	2.4 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN2 & OUT	"	"	"	"	"	"	"	"	"	"
		83	"	2.4 V	0.8 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN3 & OUT	"	"	"	"	"	"	"	"	"	"
		84	"	2.4 V	2.4 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN4 & OUT	"	"	"	"	"	"	"	"	"	"
		85	2.4 V	0.8 V	0.8 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN5 & OUT	"	"	"	"	"	"	"	"	"	"
		86	"	0.8 V	2.4 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN6 & OUT	"	"	"	"	"	"	"	"	"	"
87		"	2.4 V	0.8 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN7 & OUT	"	"	"	"	"	"	"	"	"	"	
88		"	0.8 V	0.8 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN8 & OUT	"	"	"	"	"	"	"	"	"	"	
89		0.8 V	0.8 V	0.8 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN9 & OUT	"	"	"	"	"	"	"	"	"	"	
90		"	2.4 V	2.4 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN10 & OUT	"	"	"	"	"	"	"	"	"	"	
91		"	2.4 V	0.8 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN11 & OUT	"	"	"	"	"	"	"	"	"	"	
I <sub>T-</sub>	92	2.4 V	0.8 V	0.8 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN12 & OUT	"	"	"	"	"	"	"	"	"	"	
	93	"	0.8 V	2.4 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN13 & OUT	"	"	"	"	"	"	"	"	"	"	
	94	"	2.4 V	0.8 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN14 & OUT	"	"	"	"	"	"	"	"	"	"	
	95	"	0.8 V	2.4 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN15 & OUT	"	"	"	"	"	"	"	"	"	"	
	96	"	2.4 V	0.8 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN16 & OUT	"	"	"	"	"	"	"	"	"	"	
	97	0.8 V	0.8 V	0.8 V	"	-10 V	-10 V	-10 V	-10 V	IN1 & OUT	"	"	"	"	"	"	"	"	"	"													
	98	"	0.8 V	2.4 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN2 & OUT	"	"	"	"	"	"	"	"	"	"	
	99	"	2.4 V	0.8 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN3 & OUT	"	"	"	"	"	"	"	"	"	"	
	100	"	2.4 V	2.4 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN4 & OUT	"	"	"	"	"	"	"	"	"	"	
	101	2.4 V	0.8 V	0.8 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	IN5 & OUT	"	"	"	"	"	"	"	"	"	"	

See footnotes at end of table.

















TABLE III. Group A inspection for device type 02 - Continued.

Symbol	MIL-STD-883 method	Case X test no.	Terminal conditions I/														Measured terminal	Test limits						Unit																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																				
																		Subgroup 1 T <sub>A</sub> = 25°C		Subgroup 2 T <sub>A</sub> = 125°C		Subgroup 3 T <sub>A</sub> = -55°C																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																						
			1	2	3	4	5	6	7	8	9	10	11	12	13	14		Min	Max	Min	Max	Min	Max																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																																					
I <sub>0+</sub> (OFF) overvoltage		101	V+	NC	NC	IN14	IN15	IN16	IN17	IN18	IN19	IN20	IN21	IN22	IN23	IN24	IN25	IN26	IN27	IN28	IN29	IN30	IN31	IN32	IN33	IN34	IN35	IN36	IN37	IN38	IN39	IN40	IN41	IN42	IN43	IN44	IN45	IN46	IN47	IN48	IN49	IN50	IN51	IN52	IN53	IN54	IN55	IN56	IN57	IN58	IN59	IN60	IN61	IN62	IN63	IN64	IN65	IN66	IN67	IN68	IN69	IN70	IN71	IN72	IN73	IN74	IN75	IN76	IN77	IN78	IN79	IN80	IN81	IN82	IN83	IN84	IN85	IN86	IN87	IN88	IN89	IN90	IN91	IN92	IN93	IN94	IN95	IN96	IN97	IN98	IN99	IN100	IN101	IN102	IN103	IN104	IN105	IN106	IN107	IN108	IN109	IN110	IN111	IN112	IN113	IN114	IN115	IN116	IN117	IN118	IN119	IN120	IN121	IN122	IN123	IN124	IN125	IN126	IN127	IN128	IN129	IN130	IN131	IN132	IN133	IN134	IN135	IN136	IN137	IN138	IN139	IN140	IN141	IN142	IN143	IN144	IN145	IN146	IN147	IN148	IN149	IN150	IN151	IN152	IN153	IN154	IN155	IN156	IN157	IN158	IN159	IN160	IN161	IN162	IN163	IN164	IN165	IN166	IN167	IN168	IN169	IN170	IN171	IN172	IN173	IN174	IN175	IN176	IN177	IN178	IN179	IN180	IN181	IN182	IN183	IN184	IN185	IN186	IN187	IN188	IN189	IN190	IN191	IN192	IN193	IN194	IN195	IN196	IN197	IN198	IN199	IN200	IN201	IN202	IN203	IN204	IN205	IN206	IN207	IN208	IN209	IN210	IN211	IN212	IN213	IN214	IN215	IN216	IN217	IN218	IN219	IN220	IN221	IN222	IN223	IN224	IN225	IN226	IN227	IN228	IN229	IN230	IN231	IN232	IN233	IN234	IN235	IN236	IN237	IN238	IN239	IN240	IN241	IN242	IN243	IN244	IN245	IN246	IN247	IN248	IN249	IN250	IN251	IN252	IN253	IN254	IN255	IN256	IN257	IN258	IN259	IN260	IN261	IN262	IN263	IN264	IN265	IN266	IN267	IN268	IN269	IN270	IN271	IN272	IN273	IN274	IN275	IN276	IN277	IN278	IN279	IN280	IN281	IN282	IN283	IN284	IN285	IN286	IN287	IN288	IN289	IN290	IN291	IN292	IN293	IN294	IN295	IN296	IN297	IN298	IN299	IN300	IN301	IN302	IN303	IN304	IN305	IN306	IN307	IN308	IN309	IN310	IN311	IN312	IN313	IN314	IN315	IN316	IN317	IN318	IN319	IN320	IN321	IN322	IN323	IN324	IN325	IN326	IN327	IN328	IN329	IN330	IN331	IN332	IN333	IN334	IN335	IN336	IN337	IN338	IN339	IN340	IN341	IN342	IN343	IN344	IN345	IN346	IN347	IN348	IN349	IN350	IN351	IN352	IN353	IN354	IN355	IN356	IN357	IN358	IN359	IN360	IN361	IN362	IN363	IN364	IN365	IN366	IN367	IN368	IN369	IN370	IN371	IN372	IN373	IN374	IN375	IN376	IN377	IN378	IN379	IN380	IN381	IN382	IN383	IN384	IN385	IN386	IN387	IN388	IN389	IN390	IN391	IN392	IN393	IN394	IN395	IN396	IN397	IN398	IN399	IN400	IN401	IN402	IN403	IN404	IN405	IN406	IN407	IN408	IN409	IN410	IN411	IN412	IN413	IN414	IN415	IN416	IN417	IN418	IN419	IN420	IN421	IN422	IN423	IN424	IN425	IN426	IN427	IN428	IN429	IN430	IN431	IN432	IN433	IN434	IN435	IN436	IN437	IN438	IN439	IN440	IN441	IN442	IN443	IN444	IN445	IN446	IN447	IN448	IN449	IN450	IN451	IN452	IN453	IN454	IN455	IN456	IN457	IN458	IN459	IN460	IN461	IN462	IN463	IN464	IN465	IN466	IN467	IN468	IN469	IN470	IN471	IN472	IN473	IN474	IN475	IN476	IN477	IN478	IN479	IN480	IN481	IN482	IN483	IN484	IN485	IN486	IN487	IN488	IN489	IN490	IN491	IN492	IN493	IN494	IN495	IN496	IN497	IN498	IN499	IN500	IN501	IN502	IN503	IN504	IN505	IN506	IN507	IN508	IN509	IN510	IN511	IN512	IN513	IN514	IN515	IN516	IN517	IN518	IN519	IN520	IN521	IN522	IN523	IN524	IN525	IN526	IN527	IN528	IN529	IN530	IN531	IN532	IN533	IN534	IN535	IN536	IN537	IN538	IN539	IN540	IN541	IN542	IN543	IN544	IN545	IN546	IN547	IN548	IN549	IN550	IN551	IN552	IN553	IN554	IN555	IN556	IN557	IN558	IN559	IN560	IN561	IN562	IN563	IN564	IN565	IN566	IN567	IN568	IN569	IN570	IN571	IN572	IN573	IN574	IN575	IN576	IN577	IN578	IN579	IN580	IN581	IN582	IN583	IN584	IN585	IN586	IN587	IN588	IN589	IN590	IN591	IN592	IN593	IN594	IN595	IN596	IN597	IN598	IN599	IN600	IN601	IN602	IN603	IN604	IN605	IN606	IN607	IN608	IN609	IN610	IN611	IN612	IN613	IN614	IN615	IN616	IN617	IN618	IN619	IN620	IN621	IN622	IN623	IN624	IN625	IN626	IN627	IN628	IN629	IN630	IN631	IN632	IN633	IN634	IN635	IN636	IN637	IN638	IN639	IN640	IN641	IN642	IN643	IN644	IN645	IN646	IN647	IN648	IN649	IN650	IN651	IN652	IN653	IN654	IN655	IN656	IN657	IN658	IN659	IN660	IN661	IN662	IN663	IN664	IN665	IN666	IN667	IN668	IN669	IN670	IN671	IN672	IN673	IN674	IN675	IN676	IN677	IN678	IN679	IN680	IN681	IN682	IN683	IN684	IN685	IN686	IN687	IN688	IN689	IN690	IN691	IN692	IN693	IN694	IN695	IN696	IN697	IN698	IN699	IN700	IN701	IN702	IN703	IN704	IN705	IN706	IN707	IN708	IN709	IN710	IN711	IN712	IN713	IN714	IN715	IN716	IN717	IN718	IN719	IN720	IN721	IN722	IN723	IN724	IN725	IN726	IN727	IN728	IN729	IN730	IN731	IN732	IN733	IN734	IN735	IN736	IN737	IN738	IN739	IN740	IN741	IN742	IN743	IN744	IN745	IN746	IN747	IN748	IN749	IN750	IN751	IN752	IN753	IN754	IN755	IN756	IN757	IN758	IN759	IN760	IN761	IN762	IN763	IN764	IN765	IN766	IN767	IN768	IN769	IN770	IN771	IN772	IN773	IN774	IN775	IN776	IN777	IN778	IN779	IN780	IN781	IN782	IN783	IN784	IN785	IN786	IN787	IN788	IN789	IN790	IN791	IN792	IN793	IN794	IN795	IN796	IN797	IN798	IN799	IN800	IN801	IN802	IN803	IN804	IN805	IN806	IN807	IN808	IN809	IN810	IN811	IN812	IN813	IN814	IN815	IN816	IN817	IN818	IN819	IN820	IN821	IN822	IN823	IN824	IN825	IN826	IN827	IN828	IN829	IN830	IN831	IN832	IN833	IN834	IN835	IN836	IN837	IN838	IN839	IN840	IN841	IN842	IN843	IN844	IN845	IN846	IN847	IN848	IN849	IN850	IN851	IN852	IN853	IN854	IN855	IN856	IN857	IN858	IN859	IN860	IN861	IN862	IN863	IN864	IN865	IN866	IN867	IN868	IN869	IN870	IN871	IN872	IN873	IN874	IN875	IN876	IN877	IN878	IN879	IN880	IN881	IN882	IN883	IN884	IN885	IN886	IN887	IN888	IN889	IN890	IN891	IN892	IN893	IN894	IN895	IN896	IN897	IN898	IN899	IN900	IN901	IN902	IN903	IN904	IN905	IN906	IN907	IN908	IN909	IN910	IN911	IN912	IN913	IN914	IN915	IN916	IN917	IN918	IN919	IN920	IN921	IN922	IN923	IN924	IN925	IN926	IN927	IN928	IN929	IN930	IN931	IN932	IN933	IN934	IN935	IN936	IN937	IN938	IN939	IN940	IN941	IN942	IN943	IN944	IN945	IN946	IN947	IN948	IN949	IN950	IN951	IN952	IN953	IN954	IN955	IN956	IN957	IN958	IN959	IN960	IN961	IN962	IN963	IN964	IN965	IN966	IN967	IN968	IN969	IN970	IN971	IN972	IN973	IN974	IN975	IN976	IN977	IN978	IN979	IN980	IN981	IN982	IN983	IN984	IN985	IN986	IN987	IN988	IN989	IN990	IN991	IN992	IN993	IN994	IN995	IN996	IN997	IN998	IN999	IN1000	IN1001	IN1002	IN1003	IN1004	IN1005	IN1006	IN1007	IN1008	IN1009	IN1010	IN1011	IN1012	IN1013	IN1014	IN1015	IN1016	IN1017	IN1018	IN1019	IN1020	IN1021	IN1022	IN1023	IN1024	IN1025	IN1026	IN1027	IN1028	IN1029	IN1030	IN1031	IN1032	IN1033	IN1034	IN1035	IN1036	IN1037	IN1038	IN1039	IN1040	IN1041	IN1042	IN1043	IN1044	IN1045	IN1046	IN1047	IN1048	IN1049	IN1050	IN1051	IN1052	IN1053	IN1054	IN1055	IN1056	IN1057	IN1058	IN1059	IN1060	IN1061	IN1062	IN1063	IN1064	IN1065	IN1066	IN1067	IN1068	IN1069	IN1070	IN1071	IN1072	IN1073	IN1074	IN1075	IN1076	IN1077	IN1078	IN1079	IN1080	IN1081	IN1082	IN1083	IN1084	IN1085	IN1086	IN1087	IN1088	IN1089	IN1090	IN1091	IN1092	IN1093	IN1094	IN1095	IN1096	IN1097	IN1098	IN1099	IN1100	IN1101	IN1102	IN1103	IN1104	IN1105	IN1106	IN1107	IN1108	IN1109	IN1110	IN1111	IN1112	IN1113	IN1114	IN1115	IN1116	IN1117	IN1118	IN1119	IN1120	IN1121	IN1122	IN1123	IN1124	IN1125	IN1126	IN1127	IN1128	IN1129	IN1130	IN1131	IN1132	IN1133	IN1134	IN1135	IN1136	IN1137	IN1138	IN1139	IN1140	IN1141	IN1142	IN1143	IN1144	IN1145	IN1146	IN1147	IN1148	IN1149	IN1150	IN1151	IN1152	IN1153	IN1154	IN1155	IN1156	IN1157	IN1158	IN1159	IN1160	IN1161	IN1162	IN1163	IN1164	IN1165	IN1166	IN1167	IN1168	IN1169	IN1170	IN1171	IN1172	IN1173	IN1174	IN1175	IN1176	IN1177	IN1178	IN1179	IN1180	IN1181	IN1182	IN1183	IN1184	IN1185	IN1186	IN1187	IN1188</



































TABLE III. Group A inspection for device type 04 - Continued.

Symbol	MIL-STD-883 method	Case X	Terminal conditions 1/														Test limits						Unit								
																	Subgroup 1 T <sub>A</sub> = 25 °C		Subgroup 2 T <sub>A</sub> = 125 °C		Subgroup 3 T <sub>A</sub> = -55 °C										
			1	2	3	4	5	6	7	8	9	10	11	12	13	14	Min	Max	Min	Max	Min	Max									
		Test no.	V+	OUTB	NC	IN8B	IN7B	IN6B	IN5B	IN4B	IN3B	IN2B	IN1B	GND	VREF	NC															
I <sub>D(OFF)</sub> voltage		101	15 V																												
		102	"																												
		103	"																												
		104	"																												
		105	"																												
		106	"																												
		107	"																												
		108	"																												
		109	"		0 V																										
		110	"																												
		111	"																												
		112	"																												
		113	"																												
		114	"																												
		115	"																												
		116	"																												
I+		117	"																												
I-		118	"																												
I+SBY		119	"																												
I-SBY		120	"																												
R <sub>DS1</sub>		121	"																												
		122	"																												
		123	"																												
		124	"																												
		125	"																												
		126	"																												
		127	"																												
		128	"																												
		129	"																												
		130	"																												
		131	"																												
		132	"																												
		133	"																												
		134	"																												
		135	"																												
		136	"																												
		137	"																												
		138	"																												
		139	"																												
		140	"																												
141	"																														
142	"																														
143	"																														
144	"																														
145	"																														
146	"																														
147	"																														
148	"																														
149	"																														
150	"																														

See footnotes at end of table.



TABLE III. Group A inspection for device type 04 - Continued.

Symbol	ML-STD-883 method	Case X	Terminal conditions <u>I</u>														Measured terminal	Test limits						Unit
			1	2	3	4	5	6	7	8	9	10	11	12	13	14		Subgroup 1 T <sub>A</sub> = 25 °C	Subgroup 2 T <sub>A</sub> = 125 °C	Subgroup 3 T <sub>A</sub> = -55 °C				
	Test no.	V+	NC	IN88	IN7B	IN6B	IN5B	IN4B	IN3B	IN2B	IN1B	GND	VREF	NC	Min	Max	Min	Max	Min	Max				
R <sub>DS1</sub>	151 152	15 V 15 V		-10 V -10 V								GND GND			1.5 1.5	2.0 2.0					1.5 1.5	k $\Omega$ k $\Omega$		
R <sub>DS2</sub>	153 thru 168 - Same terminal conditions as for tests 121 thru 136, except V <sub>s</sub> = ±10 V, V <sub>S</sub> = +7.5 V, and limits as shown.																							
R <sub>DS2</sub>	169 thru 184 - Same terminal conditions as for tests 137 thru 152, except V <sub>s</sub> = ±10 V, V <sub>S</sub> = -7.5 V, and limits as shown.																							
C <sub>A</sub>	3012	GND										GND			10	10					10	pF		
C <sub>OS</sub>	188 189	" "	5/									" "			50 50							" "		
C <sub>IS</sub>	190 191 192 193 194 195 196 197 198 199 200 201 202 203 204 205	" " " " " " " " " " " " " " "						4/	4/	4/	4/	" "			10 " " " " " " " " " " " " "							" " " " " " " " " " " " " " "	" " " " " " " " " " " " " " "	
C <sub>EN</sub>	206	"										"			"							"		
t <sub>ON(A)</sub> and t <sub>OFF(A)</sub>	3003 fig. 10	15 V										GND			1.000	1.500					1.000	ns		
	207 208 209 210 211 212 213 214 215 216 217 218 219 220 221 222	" " " " " " " " " " " " " " " "										GND			" " " " " " " " " " " " " " "							" " " " " " " " " " " " " " "	" " " " " " " " " " " " " " "	

See footnotes at end of table.



TABLE III. Group A Inspection for device type 04 - Continued.

Symbol	MIL-STD-883 method	Case X	Terminal conditions 1/														Measured terminal	Test Limits						Unit		
			Test no.	1	2	3	4	5	6	7	8	9	10	11	12	13		14	Subgroup 9		Subgroup 10		Subgroup 11			
																			TA = 25°C		TA = 125°C		TA = -55°C			
																			Min	Max	Min	Max	Min		Max	
					1	V+	OUTB	NC	IN8B	IN7B	IN6B	IN5B	IN4B	IN3B	IN2B	IN1B	GND	VREF	NC							
t <sub>ON</sub> (EN) and t <sub>OFF</sub> (EN)	3003 fig. 11	223	15 V				GND	GND		ENABLE TO OUTA	1,000	1,500	1,000	ns												
		224	"				"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"		
		225	"				"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"		
		226	"				"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"		
		227	"	OUT			10 V	10 V		"	"	"	"	"												
		228	"	"			-10 V	-10 V		ENABLE TO OUTB	"	"	"	"	"											
		229	"	"			10 V	10 V		"	"	"	"	"												
		230	"	"			-10 V	-10 V		"	"	"	"	"												
Subgroup 12 TA = 25°C																										
V <sub>IS0</sub>	fig. 17	231	15 V				IN	GND	GND		OUTA	50				dB										
	fig. 17	232	"				"	"	"	"	"	"	"	"	"	"	"	"	"		OUTB	"				"
V <sub>CT</sub>	fig. 18	233	"				"	"	"	"	"	"	"	"	"	"	"	"	"		OUTA	"				"
	fig. 18	234	"				"	"	"	"	"	"	"	"	"	"	"	"	"		OUTB	"				"
Subgroup 13 TA = 25°C																										
V <sub>CTE</sub>	fig. 19	235	"														GND	GND		OUTA	10				mV	
	fig. 19	236	"														GND	GND		OUTB	10				mV	
t <sub>D</sub>	fig. 16	237	15 V				GND	GND		OUTA	5				ns											
		238	"				"	"	"	"	"	"	"	"	"	"	"	"		"	"				"	
		239	"				"	"	"	"	"	"	"	"	"	"	"	"		"	"				"	
		240	"				"	"	"	"	"	"	"	"	"	"	"	"		"	"				"	
		241	"	OUT			10 V	10 V		"	"				"											
		242	"	"			-10 V	-10 V		"	"				"											
		243	"	"			10 V	10 V		"	"				"											
		244	"	"			-10 V	-10 V		"	"				"											

See footnotes at end of table.

TABLE III. Group A inspection for device type 04 - Continued.

Symbol	Case X Test no.	Terminal conditions															Measured terminal	Test limits						Unit
																		Subgroup 9 T <sub>A</sub> = 25°C		Subgroup 10 T <sub>A</sub> = 125°C		Subgroup 11 T <sub>A</sub> = -55°C		
		15	16	17	18	19	20	21	22	23	24	25	26	27	28	Min		Max	Min	Max	Min	Max		
t <sub>ON</sub> (EN) and t <sub>OFF</sub> (EN)	223 224 225 226 227 228 229 230	AZ	A1	A0	EN	IN1A	IN2A	IN3A	IN4A	IN5A	IN6A	IN7A	IN8A	V-	OUTA	1,000	1,500	1,000	11,000			ns		
V <sub>ISO</sub>	231 232	GND	GND	GND	0 V 0 V	IN	-15 V	OUT OUTB	50						dB									
V <sub>CT</sub>	233 234	"	"	"	5 V	6/ 6/	"	"	"	"	"	"	"	"	OUT OUTB	"						"		
V <sub>CTE</sub>	235 236	IN IN	IN IN	IN IN	" "	GND GND								"	OUT OUTB	10 10						mV mV		
t <sub>D</sub>	237 238 239 240 241 242 243 244				5 V	10 V -10 V 10 V -10 V GND	-15 V	OUT OUTB	5						ns									

See footnotes at end of table.

TABLE III. Group A inspection for device type 05.

Symbol	MIL-STD-883 test method	Case E	terminal conditions $V_f$																test limits						
																			Subgroup 1		Subgroup 2		Subgroup 3		
			1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	Measured terminal	TA = 25°C	TA = 125°C	TA = -55°C			
VIC (POS)		1 2 3 4	AO	EN	V-	IN1	IN2	IN3	IN4	OUT	IN8	IN7	IN6	IN5	V+	GND	AZ	A1	Min	Max	Min	Max	Min	Max	
			1 mA	1 mA	GND														1 mA		1.5				
VIC (NEG)		5 6 7 8	GND															A2							
			-1 mA	-1 mA															-1.5						
I <sub>TH</sub> 2/	3010	9 10 11 12	GND	5 V	-15 V													A2							
			GND																						
			4.0 V																						
			GND	4.0 V																					
I <sub>IL</sub> 2/	3009	13 14 15 16	5 V	5 V														A2							
			5 V	5 V																					
			0.8 V	5 V																					
			5 V	0.8 V																					
I <sub>S</sub> (OFF)		17 18 19 20 21 22 23 24 25 26 27 28 29 30 31 32	0.8 V															IN1							
			4.0 V																IN2						
			0.8 V																IN3						
			0.8 V																IN4						
			0.8 V																IN5						
			0.8 V																IN6						
			0.8 V																IN7						
			0.8 V																IN8						
			0.8 V																IN1						
			0.8 V																IN2						
			0.8 V																IN3						
			0.8 V																IN4						
			0.8 V																IN5						
			0.8 V																IN6						
			0.8 V																IN7						
			0.8 V																IN8						
I <sub>D</sub> (OFF) I <sub>D</sub> (OFF)		33 34	0.8 V															OUT							
			0.8 V																						
I <sub>D</sub> (ON)		35 36 37 38 39 40 41 42	0.8 V	4.0 V														IN1 & OUT							
			4.0 V																						
			0.8 V																						
			4.0 V																						
			0.8 V																						
			4.0 V																						
			0.8 V																						
			4.0 V																						
			0.8 V																						
			4.0 V																						

See footnotes at end of table.

TABLE III. Group A inspection for device type 05 - Continued.

Symbol	MIL-STD-883 test method	Case E	Terminal conditions																Test limits								
			Terminal conditions																Measured terminal	Subgroup 1 TA = 25°C		Subgroup 2 TA = 125°C		Subgroup 3 TA = -55°C			
			1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16		Min	Max	Min	Max	Min	Max		
Test no.	AO	EN	V-	IN1	IN2	IN3	IN4	OUT	IN8	IN7	IN6	IN5	V+	GND	AZ	AI											
I <sub>D</sub> (ON)	43	0.8 V	4.0 V	-15 V	-10 V	10 V	10 V	-10 V	10 V	10 V	10 V	10 V	15 V	GND	0.8 V	0.8 V	IN1 & OUT	-10	10	-250	250	-250	250	nA			
	44	4.0 V	"	"	10 V	10 V	10 V	"	"	"	"	"	"	"	"	"	0.8 V IN2 & OUT	"	"	"	"	"	"	"			
	45	0.8 V	"	"	10 V	-10 V	10 V	10 V	"	"	"	"	"	"	"	"	4.0 V IN3 & OUT	"	"	"	"	"	"	"			
	46	4.0 V	"	"	"	10 V	-10 V	10 V	"	"	"	"	"	"	"	"	4.0 V IN4 & OUT	"	"	"	"	"	"	"			
	47	0.8 V	"	"	"	"	"	10 V	"	"	"	-10 V	"	"	"	"	0.8 V IN5 & OUT	"	"	"	"	"	"	"			
	48	4.0 V	"	"	"	"	"	"	"	"	-10 V	10 V	"	"	"	"	0.8 V IN6 & OUT	"	"	"	"	"	"	"			
49	0.8 V	"	"	"	"	"	"	"	-10 V	10 V	10 V	"	"	"	"	4.0 V IN7 & OUT	"	"	"	"	"	"	"				
50	4.0 V	"	"	"	"	"	"	"	-10 V	10 V	10 V	"	"	"	"	4.0 V IN8 & OUT	"	"	"	"	"	"	"				
I <sub>1</sub> +	51	0 V	5.0 V	"	"	"	"	"	"	"	"	"	"	"	0 V	0 V	V+	2.0	2.0	2.0	2.0	2.0	2.0	mA			
I <sub>1</sub> -	52	"	5.0 V	"	"	"	"	"	"	"	"	"	"	"	"	"	V-	-1	-1	-1	-1	-1	-1	"			
I <sub>1</sub> *SBY	53	"	0 V	"	"	"	"	"	"	"	"	"	"	"	"	"	V+	2.0	2.0	2.0	2.0	2.0	2.0	"			
I <sub>1</sub> -SBY	54	"	0 V	"	"	"	"	"	"	"	"	"	"	"	"	"	V-	-1.0	-1.0	-1.0	-1.0	-1.0	-1.0	"			
I <sub>D</sub> +(OFF) lower voltage	55	0.8 V	0.8 V	"	33 V	33 V	33 V	0 V	"	"	"	"	"	"	GND	0.8 V	OUT	-2.0	2.0	-2.0	2.0	-2.0	2.0	μA			
	56	4.0 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	0.8 V	"	"	"	"	"	"	"			
	57	0.8 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	4.0 V	"	"	"	"	"	"	"			
	58	4.0 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	4.0 V	"	"	"	"	"	"	"			
	59	0.8 V	"	"	"	"	"	"	"	"	"	33 V	"	"	"	15 V	0.8 V	"	"	"	"	"	"	"	"		
	60	4.0 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	0.8 V	"	"	"	"	"	"	"			
	61	0.8 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	4.0 V	"	"	"	"	"	"	"			
62	4.0 V	"	"	"	"	"	"	"	-33 V	"	"	"	"	"	"	4.0 V	"	"	"	"	"	"	"				
I <sub>D</sub> -(OFF) lower voltage	63	0.8 V	"	"	-33 V	-33 V	-33 V	"	"	"	"	"	"	"	GND	0.8 V	"	"	"	"	"	"	"	"			
	64	4.0 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	0.8 V	"	"	"	"	"	"	"			
	65	0.8 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	4.0 V	"	"	"	"	"	"	"			
	66	4.0 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	4.0 V	"	"	"	"	"	"	"			
	67	0.8 V	"	"	"	"	"	"	"	"	"	-33 V	"	"	"	15 V	0.8 V	"	"	"	"	"	"	"			
	68	4.0 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	0.8 V	"	"	"	"	"	"	"			
	69	0.8 V	"	"	"	"	"	"	"	"	"	-33 V	"	"	"	"	4.0 V	"	"	"	"	"	"	"			
70	4.0 V	"	"	"	"	"	"	"	-33 V	"	"	"	"	"	"	4.0 V	"	"	"	"	"	"	"				
R <sub>D</sub> S1	71	0.8 V	4.0 V	"	10 V	10 V	10 V	100 μA	"	"	"	"	"	"	0.8 V	0.8 V	IN1 & OUT	1.5	1.5	1.5	1.5	1.5	1.5	kΩ			
	72	4.0 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	0.8 V IN2 & OUT	"	"	"	"	"	"	"			
	73	0.8 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	4.0 V IN3 & OUT	"	"	"	"	"	"	"			
	74	4.0 V	"	"	"	"	10 V	"	"	"	"	"	"	"	"	"	4.0 V IN4 & OUT	"	"	"	"	"	"	"			
	75	0.8 V	"	"	"	"	"	"	"	"	10 V	"	"	"	"	"	4.0 V IN5 & OUT	"	"	"	"	"	"	"			
	76	4.0 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	0.8 V IN6 & OUT	"	"	"	"	"	"	"			
	77	0.8 V	"	"	"	"	"	"	"	"	10 V	"	"	"	"	"	4.0 V IN7 & OUT	"	"	"	"	"	"	"			
	78	4.0 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	4.0 V IN8 & OUT	"	"	"	"	"	"	"			
	79	0.8 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	0.8 V IN1 & OUT	"	"	"	"	"	"	"			
	80	4.0 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	0.8 V IN2 & OUT	"	"	"	"	"	"	"			
	81	0.8 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	4.0 V IN3 & OUT	"	"	"	"	"	"	"			
82	4.0 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	4.0 V IN4 & OUT	"	"	"	"	"	"	"				
83	0.8 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	0.8 V IN5 & OUT	"	"	"	"	"	"	"				
84	4.0 V	"	"	"	"	"	"	"	"	"	-10 V	"	"	"	"	0.8 V IN6 & OUT	"	"	"	"	"	"	"				
85	0.8 V	"	"	"	"	"	"	"	"	-10 V	"	"	"	"	"	4.0 V IN7 & OUT	"	"	"	"	"	"	"				
86	4.0 V	"	"	"	"	"	"	"	-10 V	"	"	"	"	"	"	4.0 V IN8 & OUT	"	"	"	"	"	"	"				
R <sub>D</sub> S2	87 thru 102	Same terminal conditions as for tests 71 thru 86, except V* = ±10 V, V <sub>S</sub> = ±7.5, and limits as shown.																					2.2	2.2	2.2	2.2	2.2

See footnotes at end of table.

TABLE III. Group A Inspection for device type 05 - Continued.

Symbol	MIL-STD-883 test method	Case E	Terminal conditions 17																Measured terminal	Test limits			Unit				
																				Subgroup 4 T <sub>A</sub> = 25 °C							
			1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16			Min	Max					
C <sub>A</sub>	3012	103	AD	EN	V-	IN1	IN2	IN3	IN4	OUT	IN8	IN7	IN6	IN5	V+	GND	AZ	A1	A2	A1	A0	10	10	10	pF		
C <sub>OS</sub>	"	106	0 V	"	"	"	"	"	5/	"	"	"	"	"	"	0 V	0 V	OUT	"	"	"	45	"	"	"		
C <sub>IS</sub>	"	107	"	0 V	"	4/	"	"	4/	"	"	"	"	"	"	"	"	"	IN1	IN2	IN3	IN4	IN5	IN6	IN7	IN8	"
C <sub>EN</sub>	"	115	4/	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	EN	"	"	"	"	"	"	"	
t <sub>ON</sub> (A)	3003	116	GND	5 V	-15 V	GND	GND	GND	GND	OUT	10 V	GND	GND	GND	15 V	GND	GND	GND	GND	GND	GND	1,000	11,500	1,000	ns		
t <sub>OFF</sub> (A)	"	117	"	"	"	"	"	"	"	"	-10 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"		
t <sub>ON</sub> (EN)	"	118	"	"	"	"	"	"	"	"	-10 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	
t <sub>OFF</sub> (EN)	"	119	"	"	"	"	"	"	"	"	-10 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	
t <sub>ON</sub> (EN)	"	120	"	"	"	"	"	"	"	"	-10 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	
t <sub>OFF</sub> (EN)	"	121	"	"	"	"	"	"	"	"	-10 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	
t <sub>ON</sub> (EN)	"	122	"	"	"	"	"	"	"	"	-10 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	
t <sub>OFF</sub> (EN)	"	123	"	"	"	"	"	"	"	"	-10 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	
t <sub>ON</sub> (EN)	3003	124	GND	5 V	-15 V	GND	GND	GND	GND	OUT	10 V	GND	GND	GND	15 V	GND	GND	GND	GND	GND	GND	1,000	11,500	1,000	ns		
t <sub>OFF</sub> (EN)	"	125	"	"	"	"	"	"	"	"	-10 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	
t <sub>ON</sub> (EN)	"	126	"	"	"	"	"	"	"	"	-10 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	
t <sub>OFF</sub> (EN)	"	127	"	"	"	"	"	"	"	"	-10 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	
V <sub>ISO</sub>	fig. 17	128	GND	0 V	-15 V	IN	IN	IN	IN	OUT	IN	IN	IN	IN	15 V	GND	GND	GND	GND	GND	GND	50	"	"	"	dB	
V <sub>CT</sub>	fig. 18	129	GND	5 V	-15 V	6/	IN	IN	IN	OUT	IN	IN	IN	IN	15 V	GND	GND	GND	GND	GND	GND	50	"	"	"	dB	
V <sub>CTE</sub>	fig. 19	130	IN	5 V	-15 V	GND	"	"	"	"	"	"	"	"	15 V	GND	IN	IN	OUT	"	"	10	"	"	"	mV	
t <sub>D</sub>	fig. 16	131	"	5 V	-15 V	10 V	10 V	10 V	10 V	OUT	10 V	10 V	10 V	10 V	15 V	GND	GND	GND	GND	GND	GND	5	"	"	"	ns	
	"	132	"	"	"	-10 V	-10 V	-10 V	-10 V	"	-10 V	-10 V	-10 V	-10 V	"	"	"	"	"	"	"	"	"	"	"	"	
	"	133	"	"	"	10 V	10 V	10 V	10 V	"	10 V	10 V	10 V	10 V	"	"	"	"	"	"	"	"	"	"	"	"	
	"	134	"	"	"	-10 V	-10 V	-10 V	-10 V	"	-10 V	-10 V	-10 V	-10 V	"	"	"	"	"	"	"	"	"	"	"	"	

See footnotes at end of table.

TABLE III. Group A Inspection for device type 06.

Symbol	MIL-STD-883 test method	Case E	Terminal conditions 1/																Test limits					
			Terminal conditions 1/																Subgroup 1		Subgroup 2		Subgroup 3	
			1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	Measured terminal	Min	Max	Min	Max	Min
V <sub>IC</sub> (POS)	AO	EN	V-	IN1A	IN2A	IN3A	IN4A	OUTA	OUTB	IN4B	IN3B	IN2B	IN1B	V+	GND	AI	A1	1.5	1.5	1.5	V			
				IN1A	IN2A	IN3A	IN4A	OUTA	OUTB	IN4B	IN3B	IN2B	IN1B	V+	GND	AI								
				IN1A	IN2A	IN3A	IN4A	OUTA	OUTB	IN4B	IN3B	IN2B	IN1B	V+	GND	AI								
V <sub>IC</sub> (NEG)	AO	EN	V-	IN1A	IN2A	IN3A	IN4A	OUTA	OUTB	IN4B	IN3B	IN2B	IN1B	V+	GND	AI	A1	-1.5	-1.5	-1.5	V			
				IN1A	IN2A	IN3A	IN4A	OUTA	OUTB	IN4B	IN3B	IN2B	IN1B	V+	GND	AI								
				IN1A	IN2A	IN3A	IN4A	OUTA	OUTB	IN4B	IN3B	IN2B	IN1B	V+	GND	AI								
I <sub>TH</sub> 2/	GND	5 V	-15 V	IN1A	IN2A	IN3A	IN4A	OUTA	OUTB	IN4B	IN3B	IN2B	IN1B	V+	GND	AI	A1	-0.1	-0.1	-0.1	1.0			
				IN1A	IN2A	IN3A	IN4A	OUTA	OUTB	IN4B	IN3B	IN2B	IN1B	V+	GND	AI								
				IN1A	IN2A	IN3A	IN4A	OUTA	OUTB	IN4B	IN3B	IN2B	IN1B	V+	GND	AI								
I <sub>IL</sub> 2/	GND	5 V	5 V	IN1A	IN2A	IN3A	IN4A	OUTA	OUTB	IN4B	IN3B	IN2B	IN1B	V+	GND	AI	A1	-1.0	-1.0	-1.0	0.1			
				IN1A	IN2A	IN3A	IN4A	OUTA	OUTB	IN4B	IN3B	IN2B	IN1B	V+	GND	AI								
				IN1A	IN2A	IN3A	IN4A	OUTA	OUTB	IN4B	IN3B	IN2B	IN1B	V+	GND	AI								
I <sub>S</sub> (OFF)	GND	5 V	5 V	IN1A	IN2A	IN3A	IN4A	OUTA	OUTB	IN4B	IN3B	IN2B	IN1B	V+	GND	AI	IN1A	-1	-1	-1	50			
				IN1A	IN2A	IN3A	IN4A	OUTA	OUTB	IN4B	IN3B	IN2B	IN1B	V+	GND	AI								
				IN1A	IN2A	IN3A	IN4A	OUTA	OUTB	IN4B	IN3B	IN2B	IN1B	V+	GND	AI								
I <sub>D</sub> (OFF)	GND	5 V	5 V	IN1A	IN2A	IN3A	IN4A	OUTA	OUTB	IN4B	IN3B	IN2B	IN1B	V+	GND	AI	OUTA	-10	-10	-10	125			
				IN1A	IN2A	IN3A	IN4A	OUTA	OUTB	IN4B	IN3B	IN2B	IN1B	V+	GND	AI								
				IN1A	IN2A	IN3A	IN4A	OUTA	OUTB	IN4B	IN3B	IN2B	IN1B	V+	GND	AI								
I <sub>D</sub> (ON)	GND	5 V	5 V	IN1A	IN2A	IN3A	IN4A	OUTA	OUTB	IN4B	IN3B	IN2B	IN1B	V+	GND	AI	IN1A & OUTA	-10	-10	-10	125			
				IN1A	IN2A	IN3A	IN4A	OUTA	OUTB	IN4B	IN3B	IN2B	IN1B	V+	GND	AI								
				IN1A	IN2A	IN3A	IN4A	OUTA	OUTB	IN4B	IN3B	IN2B	IN1B	V+	GND	AI								

See footnotes at end of table.



TABLE III. Group A inspection for device type D6 - Continued.

Symbol	MIL-STD-883C E test method	Case no.	terminal conditions																test limits			Unit	
																			Subgroup 4				
			1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	Measured terminal	Min	Max		
C <sub>A</sub>	3012	101	EN	IN1A	IN2A	IN3A	IN4A	OUTA	OUTB	IN4B	IN3B	IN2B	IN1B	V+	GND	A1	A0	10	10	pF			
		102	GND														4/	A1	10	10	pF		
C <sub>OS</sub>		103	0 V					5/									OUTA	25	25	"			
		104	"						5/								OUTB	25	25	"			
C <sub>IS</sub>		105	"														IN1A	10		"			
		106	"				4/										IN2A	"		"			
		107	"				4/										IN3A	"		"			
		108	"				4/										IN4A	"		"			
		109	"				4/						4/				IN1B	"		"			
		110	"				4/						4/				IN2B	"		"			
		111	"				4/						4/				IN3B	"		"			
		112	"				4/						4/				IN4B	"		"			
		113	"	4/												GND		EN	"		"		
		t <sub>ON</sub> (A) and t <sub>OFF</sub> (A)	3003 fig. 14	114	5 V														ADDRESS IN TO OUTA	1,000	1,500	1,000	ns
				115	"														"	"	"	"	"
116	"																"	"	"	"	"		
117	"																	"	"	"	"		
118	"																	"	"	"	"		
119	"																	"	"	"	"		
120	"																	"	"	"	"		
121	"																	"	"	"	"		
122	"																	"	"	"	"		
123	"																	"	"	"	"		
124	"																	"	"	"	"		
125	"																	"	"	"	"		
126	"																	"	"	"	"		
127	"																	"	"	"	"		
128	"															"	"	"	"				
t <sub>ON</sub> (EN) and t <sub>OFF</sub> (EN)	3003 fig. 15	130	5 V														ENABLE TO OUTA	"	"	"	"		
		131	"														"	"	"	"			
		132	"														"	"	"	"			
		133	"														"	"	"	"			
		134	"														"	"	"	"			
		135	"														"	"	"	"			
		136	"														"	"	"	"			
137	"														"	"	"	"					

See footnotes at end of table.

TABLE III. Group A inspection for device type 06 - Continued.

Symbol	MIL-STD-883 test method	Case E	terminal conditions I																Test limits		Unit	
			1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	Measured terminal	Subgroup 12 TA = 25 C		
			AO	EN	V-	IN1A	IN2A	IN3A	IN4A	OUTA	OUTB	IN4B	IN3B	IN2B	IN1B	V+	GND	AI		Min		Max
VISO	fig. 17 fig. 17	138 139	GND	0 V	-15 V	IN	IN	IN	IN	IN	IN	IN	IN	IN	15 V	GND	GND	OUTA OUTB	50	"	dB	
VCT	fig. 18 fig. 18	140 141	"	5 V	"	6/ 6/	"	"	"	"	"	"	"	"	"	"	"	OUTA OUTB	"	"	"	
VCTE	fig. 19 fig. 19	142 143	IN	"	"	GND	GND	"	OUT	"	"	"	"	"	"	"	IN	OUTA OUTB	"	10	mV	
td	fig. 16	144		5 V	-15 V	10 V	10 V	10 V	10 V	10 V	10 V	10 V	10 V	10 V	15 V	GND	GND	OUT				
	"	145		"	"	-10 V	-10 V	-10 V	-10 V	-10 V	-10 V	-10 V	-10 V	-10 V	"	GND	GND	OUT	5	"	ns	
	"	146		"	"	10 V	10 V	10 V	10 V	10 V	10 V	10 V	10 V	10 V	"	GND	GND	"	"	"	"	
	"	147		"	"	-10 V	-10 V	-10 V	-10 V	-10 V	-10 V	-10 V	-10 V	-10 V	"	GND	GND	"	"	"	"	
	"	148		"	"	GND	GND	GND	GND	GND	GND	GND	GND	GND	"	GND	GND	OUT	"	"	"	
	"	149		"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
"	150		"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	
"	151		"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	

See footnotes at end of table.



TABLE III. Group A Inspection for device type 07 - Continued.

Symbol	MIL-STD-883 test method	Case E	Terminal conditions 1/																Test limits											
			Terminal conditions 1/																Subgroup 1 T <sub>A</sub> = 25 °C				Subgroup 2 T <sub>A</sub> = 125 °C				Subgroup 3 T <sub>A</sub> = -55 °C			
			1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	Measured terminal	Min	Max	Min	Max	Min	Max	Min	Max			
I <sub>T+</sub>		43	0 V	5.0 V	-15 V								15 V	GND	0 V	0 V	V+		12		12		12		12	mA				
I <sub>T-</sub>		44	"	5.0 V	"								"	"	"	"	V-		-12		-12		-12		-12	"				
I <sub>T+SBY</sub>		45	"	0 V	"								"	"	"	"	V+		3.5		3.5		3.5		3.5	"				
I <sub>T-SBY</sub>		46	"	0 V	"								"	"	"	"	V-		-3.5		-3.5		-3.5		-3.5	"				
R <sub>DS1</sub>		47	0.8 V	4.5 V	"	10 V											1 mA									400	Ω			
		48	2.4 V	"	"	10 V																				"				
		49	0.8 V	"	"	10 V	10 V																			"				
		50	2.4 V	"	"																					"				
		51	0.8 V	"	"							10 V														"				
		52	2.4 V	"	"																					"				
		53	0.8 V	"	"							10 V														"				
		54	2.4 V	"	"																					"				
		55	0.8 V	"	"																					"				
		56	2.4 V	"	"																					"				
		57	0.8 V	"	"																					"				
		58	2.4 V	"	"																					"				
		59	0.8 V	"	"																					"				
		60	2.4 V	"	"																					"				
		61	0.8 V	"	"																					"				
		62	2.4 V	"	"																					"				
R <sub>DS2</sub>		63 thru 78	Same terminal conditions as tests 47 thru 62, except V <sub>s</sub> = ±10 V, V <sub>S</sub> = +7.5 V and limits as shown.																1,000		1,000		1,000		1,000	"				
R <sub>DS2</sub>		79 thru 94	Same terminal conditions as tests 47 thru 62, except V <sub>s</sub> = ±10 V, V <sub>S</sub> = -7.5 V and limits as shown.																1,000		1,000		1,000		1,000	"				
I <sub>CA</sub>		95																												
		96																												
		97	4/																											
I <sub>CS</sub>		98	0 V																											
		99	"	0 V																										
		100	"	"																										
		101	"	"																										
		102	"	"																										
		103	"	"																										
		104	"	"																										
		105	"	"																										
		106	"	"																										
I <sub>EN</sub>		107	"	4/																										

See footnotes at end of table.

TABLE III. Group A inspection for device type 07 - Continued.

Symbol	MIL-STD-883 test method	Case E	Terminal conditions 1/																Test limits																						
			Terminal conditions 1/																Test limits																						
			1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	Subgroup 9 TA = 25 C	Subgroup 10 TA = 125 C	Subgroup 11 TA = -55 C	Unit																			
AO	EN	V-	IN1	IN2	IN3	IN4	OUT	IN8	IN7	IN6	IN5	V+	GND	AZ	AI	Min	Max	Min	Max	Min	Max																				
t <sub>ON</sub> (A) and t <sub>OFF</sub> (A)	3003	108		5 V	GND	GND	GND	OUT	10 V	GND	GND	GND	15 V	GND				1,000			ns																				
		110		"	"	"	"	"	-10 V	"	"	"	"	"	"	"	"	"	"	"	"																				
		111		"	"	"	"	"	10 V	"	"	"	"	"	"	"	"	"	"	"	"																				
		112		"	"	"	"	"	-10 V	"	"	"	"	"	"	"	"	"	"	"	"																				
		114		"	"	"	"	"	GND	"	"	"	"	"	"	"	"	"	"	"	"																				
t <sub>ON</sub> (EN) and t <sub>OFF</sub> (EN)	3003	116		"	10 V	10 V	10 V	"	10 V	10 V	10 V	10 V	"	"	GND	"	"	"	"	"	"																				
		117		"	-10 V	-10 V	-10 V	"	-10 V	-10 V	-10 V	-10 V	"	"	"	"	"	"	"	"	"																				
		118		"	10 V	10 V	10 V	"	10 V	10 V	10 V	10 V	"	"	"	"	"	"	"	"	"																				
		119		"	-10 V	-10 V	-10 V	"	-10 V	-10 V	-10 V	-10 V	"	"	"	"	"	"	"	"	"																				
Subgroup 12 TA = 25 C																						Min		Max																	
V <sub>ISO</sub>	fig. 17	120	GND	0 V	-15 V	IN	15 V	GND	GND	GND	GND	50			dB																										
V <sub>CT</sub>	fig. 18	121	GND	5 V	-15 V	6/	IN	IN	IN	IN	IN	IN	15 V	GND	GND	GND	GND	50			dB																				
V <sub>CTE</sub>	fig. 19	122	IN	5 V	-15 V	GND		OUT					15 V	GND	IN	IN	OUT	10			mV																				
Subgroup 13 TA = 25 C																						Min		Max																	
t <sub>0</sub>	fig. 16	123		5 V	-15 V	10 V	10 V	10 V	10 V	10 V	10 V	10 V	10 V	15 V	GND				5			ns																			
		124		"	"	-10 V	"	"	"	"	"	"	"	"	"	"																									
		125		"	"	10 V	"	"	"	"	"	"	"	"	"	"																									
		126		"	"	-10 V	"	"	"	"	"	"	"	"	"	"																									

See footnotes at end of table.



TABLE III. Group A inspection for device type 08 - Continued.

Symbol	MIL-STD-883 test method	Case E	terminal conditions 1/																Test limits								
			1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	Measured terminal	Subgroup 1 I <sub>A</sub> = 25 °C		Subgroup 2 I <sub>A</sub> = 125 °C		Subgroup 3 I <sub>A</sub> = -55 °C			
			AO	EN	V-	IN1A	IN2A	IN3A	IN4A	OUTA	OUTB	IN4B	IN3B	IN2B	IN1B	V+	GND	AI		Min	Max	Min	Max	Min	Max		
I+		43	0 V	5.0 V	-15 V										15 V	GND	0 V	V+		12	12		12	12	mA		
I-		44	"	5.0 V	"										"	"	"	V-		-12	-12		-12	-12	"		
I+SBY		45	"	0 V	"										"	"	"	V+		3.5	3.5		3.5	3.5	"		
I-SBY		46	"	0 V	"										"	"	"	V-		-3.5	-3.5		-3.5	-3.5	"		
R0S1		47	0.8 V	4.5 V	"	10 V	"	"	1 mA						"	"	"	0.8 V	IN1A & OUTA		400	500		400	Ω		
		48	2.4 V	"	"	10 V	"	"	"						"	"	"	0.8 V	IN2A & OUTA		"	"		"	"		
		49	0.8 V	"	"	"	10 V	"	"						"	"	"	2.4 V	IN3A & OUTA		"	"		"	"		
		50	2.4 V	"	"	"	"	"	"	1 mA					"	"	"	2.4 V	IN4A & OUTA		"	"		"	"		
		51	0.8 V	"	"	"	"	"	"				10 V		"	"	"	0.8 V	IN1B & OUTB		"	"		"	"		
		52	2.4 V	"	"	"	"	"	"				10 V		"	"	"	0.8 V	IN2B & OUTB		"	"		"	"		
		53	0.8 V	"	"	"	"	"	"	"					"	"	"	2.4 V	IN3B & OUTB		"	"		"	"		
		54	2.4 V	"	"	"	"	"	"	"	10 V				"	"	"	0.8 V	IN4B & OUTB		"	"		"	"		
		55	0.8 V	"	"	"	"	"	"	-1 mA					"	"	"	0.8 V	IN1A & OUTA		"	"		"	"		
		56	2.4 V	"	"	"	"	"	"	"					"	"	"	2.4 V	IN2A & OUTA		"	"		"	"		
		57	0.8 V	"	"	"	"	"	"	"					"	"	"	0.8 V	IN3A & OUTA		"	"		"	"		
		58	2.4 V	"	"	"	"	"	"	"					"	"	"	2.4 V	IN4A & OUTA		"	"		"	"		
		59	0.8 V	"	"	"	"	"	"	"			-10 V		"	"	"	0.8 V	IN1B & OUTB		"	"		"	"		
		60	2.4 V	"	"	"	"	"	"	"			-10 V		"	"	"	0.8 V	IN2B & OUTB		"	"		"	"		
	61	0.8 V	"	"	"	"	"	"	"					"	"	"	2.4 V	IN3B & OUTB		"	"		"	"			
	62	2.4 V	"	"	"	"	"	"	"	-10 V				"	"	"	2.4 V	IN4B & OUTB		"	"		"	"			
R0S2			63 thru 78 - Same terminal conditions as tests 47 thru 62, except V* = ±10 V, V <sub>S</sub> = ±7.5 V and limits as shown.																1,000	1,000	1,000	1,000	"				
C <sub>A</sub>	3012	79																	Subgroup 4 I <sub>A</sub> = 25 °C								
			4/																		Min	Max					
C <sub>OS</sub>		81																									
			0 V																								
C <sub>IS</sub>		83																									
			4/																								
			0 V																								
			"																								
			"																								
			"																								
C <sub>EN</sub>		91																									
			4/																								

See footnotes at end of table.

TABLE III. Group A inspection for device type 08 - Continued.

Symbol	MIL-STD-883 Test method	Case E	Terminal conditions 1/																test limits								
			Terminal conditions 1/																Subgroup 9 T <sub>A</sub> = 25°C			Subgroup 10 T <sub>A</sub> = 125°C			Subgroup 11 T <sub>A</sub> = -55°C		
			1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	Min	Max	Min	Max	Min	Max			
t <sub>ON</sub> (A) and t <sub>OFF</sub> (A)	3003 fig. 14		A0	EN	V-	IN1A	IN2A	IN3A	IN4A	OUTA	OUTB	IN4B	IN3B	IN2B	IN1B	V+	GND	A1	ADDRESS IN TO OUTA	1,000	11,500	1,000	11,000	ns			
t <sub>ON</sub> (EN) and t <sub>OFF</sub> (EN)	fig. 15	108	GND			10 V	10 V	10 V	10 V	OUT		GND							ENABLE TO OUTA	"	"	"	"	"			
V <sub>ISO</sub>	fig. 17/ fig. 17/	116 117	GND	0 V	-15 V	IN	IN	IN	IN	OUT	OUT	IN	IN	IN	IN	15 V	GND	GND	OUTA OUTB	50	"	"	"	dB			
V <sub>CT</sub>	fig. 18 fig. 18	118 119	"	5 V	"	6/ 6/	"	"	"	OUT	OUT	"	"	"	"	"	"	"	OUTA OUTB	"	"	"	"	"			
V <sub>CTE</sub>	fig. 19 fig. 19	120 121	IN	"	"	GND	GND	"	"	OUT	OUT	"	"	"	"	"	"	"	OUTA OUTB	10	10	"	"	mV			
t <sub>D</sub>	fig. 16	122		5 V	-15 V	10 V	10 V	10 V	10 V	OUT	OUT	GND	GND	GND	GND	15 V	GND	GND	OUTA	5	"	"	"	ns			
		123		"	"	-10 V	-10 V	-10 V	-10 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"			
		124		"	"	10 V	10 V	10 V	10 V	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"			
		125		"	"	-10 V	-10 V	-10 V	-10 V	OUT	OUT	10 V	OUTB	"	"	"	"	"									
		126		"	"	GND	GND	GND	GND	"	"	10 V	"	"	"	"	"	"									
		127		"	"	"	"	"	"	"	"	-10 V	"	"	"	"	"	"									
		128		"	"	"	"	"	"	"	"	10 V	"	"	"	"	"	"									
		129		"	"	"	"	"	"	"	"	-10 V	"	"	"	"	"	"									

See footnotes at end of table.

- 1/ Pins not designated may be high-level logic or open. Exceptions are as follows:  $V_{IC(POS)}$  tests, the  $V-$ , GND terminal shall be open;  $V_{IC(NEG)}$  tests, the  $V+$  terminal shall be open.
- 2/ The device manufacturer may, at his option, measure  $I_{IL}$  and  $I_{IH}$  at  $25^{\circ}C$  for each individual input or measure all inputs together.
- 3/ The  $I_S$  and  $I_D$  measurements shall be performed in sequence.
- 4/  $C_A$ ,  $C_{FN}$ , and  $C_{IS}$  - Connect capacitance bridge between measured terminal and  $V_{SS}$ , frequency = 1 MHz, see 4.4.1c.
- 5/  $C_{OS}$  - Connect capacitance bridge between measured output and  $V_{SS}$ , frequency = 1 MHz, see 4.4.1c.
- 6/ Connect input to ground through a  $1\text{ k}\Omega \pm 5\%$  resistor.

4.4.2 Group B inspection. Group B inspection shall be in accordance with table II of method 5005 of MIL-STD-883 and as follows:

- a. Electrical parameters shall be as specified in table II herein. For class S devices, delta limits shall apply only to subgroup 5 of group B inspection.
- b. Steady state life test for class S devices shall be in accordance with table IIa of method 5005 of MIL-STD-883, using an accelerated burn-in circuit approved by the qualifying activity. If the alternate burn-in conditions are used, the circuit shown on figure 7 shall be used.

4.4.3 Group C inspection. Group C inspection shall be in accordance with table III of method 5005 of MIL-STD-883 and as follows:

- a. End-point electrical parameters shall be as specified in table II herein. Delta limits shall apply only to subgroup 1 of group C inspection.
- b. Steady state life test (method 1005 of MIL-STD-883) conditions:
  1. Test condition C using the circuit shown on figure 6 or test condition D using the circuit shown on figure 7.
  2.  $T_A = 125^\circ\text{C}$ , minimum for 1,000 hours.
- c. A special subgroup shall be added to the group C inspection requirements for class B devices, and shall consist of the tests, conditions, and limits as specified for subgroups 10 and 11 of group A.
- d. A special subgroup shall be added to group C inspection for class B devices only and it shall consist of group A, subgroup 12 as specified in table III herein. This special subgroup shall be performed on each device type that is qualified from those listed in 1.2.1 herein. After initial qualification, the special subgroup shall be performed periodically on a single device type selected from those device types previously qualified. A sample of 5 devices (of the device type to be inspected) shall be chosen and submitted to test with no failures allowed. If not more than 1 failure is found in the first sample of 5, a second sample of 5 is permitted with no further failures allowed. When more than one device type is qualified, the single device type selected shall be a different device for each subsequent periodic inspection until all qualified device types have been inspected. The sequence of single device types shall be repeated to fulfill the periodic inspection requirement.

4.4.4 Group D inspection. Group D inspection shall be in accordance with table IV of method 5005 of MIL-STD-883 and as follows:

- a. End-point electrical parameters shall be as specified in table III herein.
- b. A special subgroup shall be added to group D inspection for class S devices only and it shall consist of the group A subgroups 4 and 7 as specified in table III herein. This special subgroup shall be performed on each device type that is qualified from those listed in 1.2.1 herein. After initial qualification, the special subgroup shall be performed periodically on a single device type selected from those device types previously qualified. When more than one device type is qualified, the single device type selected shall be a different device type for each subsequent periodic inspection until all qualified device types have been inspected. The sequence of single device types shall be repeated to fulfill the periodic inspection requirement.

4.5 Methods of inspection. Methods of inspection shall be as specified in the appropriate tables. Electrical test circuits as prescribed herein or in the referenced test methods of MIL-STD-883 shall be acceptable. Other test circuits shall require the approval of the qualifying activity.

4.5.1 Voltages and currents. All voltages values given are referenced to the ground terminal of the device under test (DUT). Current values given are for conventional current and are positive when flowing into the referenced terminal.

4.5.2 Life test and burn-in cooldown procedure. When the devices are measured at 25°C following application of the steady state life or burn-in test condition, they shall be cooled to within 10°C of their power stable condition prior to removal of the bias.

4.6 Data reporting. When specified in the contract or purchase order, a copy of the following data, as applicable, shall be supplied:

- a. Attributes data for all screening tests (see 4.2) and variables data for all static burn-in, dynamic burn-in, and operating life tests.
- b. The quality conformance inspection data (see 4.4).

5. PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-M-38510. The devices covered by this specification require electrostatic protection.

6. NOTES

6.1 Intended use. Microcircuits conforming to this specification are intended for original equipment design application and logistic support of existing equipment.

6.2 Ordering data. The contract or purchase order should specify the following:

- a. Complete part number (see 1.2).
- b. Requirements for delivery of one copy of the quality conformance inspection data pertinent to the device inspection lot to be supplied with each shipment supplied by the device manufacturer, if applicable.
- c. Requirement for certificate of compliance, if applicable.
- d. Requirements for notification of change of product or process to procuring activity in addition to notification to the qualifying activity, if applicable.
- e. Requirements for failure analysis (including required test condition of method 5003 of MIL-STD-883), corrective action, and reporting of results, if applicable.
- f. Requirements for product assurance options.
- g. Requirements special lead lengths or lead forming, if applicable. These requirements shall not affect the part number.
- h. Requirements for "JAN" marking.

6.3 Abbreviations, symbols, and definitions. The abbreviations, symbols, and definitions used herein are defined in MIL-M-38510, MIL-STD-1313, and as follows:

V <sub>IC</sub> - - - - -	Input clamp voltage.
I <sub>IL</sub> - - - - -	Low level (address) input current.
I <sub>IH</sub> - - - - -	High level (address) input current.
I <sub>S(OFF)</sub> - - - - -	Leakage current into the source terminal of an "OFF" switch.
I <sub>D(OFF)</sub> - - - - -	Leakage current into the drain terminal of an "OFF" switch.

$I_{D(ON)}$	- - - - -	Leakage current from an "ON" driver into the switch.
$I(+)$	- - - - -	Positive supply current.
$I(-)$	- - - - -	Negative supply current.
$I(SBY)$	- - - - -	Standby supply current.
$R_{ON}$	- - - - -	Resistance of an "ON" switch.
$C_A$	- - - - -	Address capacitance.
$C_{OS}$	- - - - -	Output switch capacitance.
$C_{IS}$	- - - - -	Input switch capacitance.
$C_{IOS}$	- - - - -	Input to output (feedthrough) capacitance.
$t_{PLH}$	- - - - -	Propagation delay time: low to high level.
$t_{PHL}$	- - - - -	Propagation delay time: high to low level.
GND	- - - - -	Electrical ground.
VREF	- - - - -	Reference voltage.
A	- - - - -	Address input to switch.
EN	- - - - -	Enable.
O/I	- - - - -	Output/Input.
I/O	- - - - -	Input/Output.

TABLE IV. Group C end-point electrical parameters ( $T_A = 25^\circ\text{C}$ ).

Parameter	Device types					
	01, 07	02	03, 08	04	05	06
$R_{ON}$	50 $\Omega$ or 10% <sup>1/</sup>	150 $\Omega$ or 10%	50 $\Omega$ or 10%	150 $\Omega$ or 10%	150 $\Omega$ or 10% <sup>1/</sup>	150 $\Omega$ or 10% <sup>1/</sup>
$I_{D(OFF)}$	15 nA	15 nA	15 nA	15 nA	15 nA	15 nA
$I_{S(OFF)}$	15 nA	15 nA	15 nA	15 nA	15 nA	15 nA

<sup>1/</sup> Whichever is greater.

<sup>2/</sup> Each of the above parameters shall be recorded before and after the required burn-in or life tests to determine deltas ( $\Delta$ ).

6.4 Logistic support. Lead materials and finishes (see 3.3) are interchangeable. Unless otherwise specified, microcircuits acquired to Government logistic support will be procured to device class B (see 1.2.2), and lead material and finish C (see 3.3). Longer length leads and lead forming shall not affect the part number.

6.5 Substitutability. The cross-reference information below is presented for the convenience of users. Microcircuits covered by this specification will functionally replace the listed generic-industry type. Generic-industry microcircuit types may not have equivalent operational performance characteristics across military temperature ranges or reliability factors equivalent to MIL-M-38510 device types and may have slight physical variations in relation to case size. The presence of this information shall not be deemed as permitting substitution of generic-industry types for MIL-M-38510 types or as a waiver of any of the provisions of MIL-M-38510.

<u>Military device type</u>	<u>Generic-industry type</u>
01	506, 6116
02	506A
03	507, 6216
04	507A
05	508A
06	509A
07	508, 6108
08	509, 6208

**6.6 Handling.** MOS devices must be handled with certain precautions to avoid damage due to accumulation of static charge. Input protective devices have been designed in the chip to minimize the effect of this static buildup. However, the following handling practices are recommended:

- a. Devices should be handled on benches with conductive and grounded surface.
- b. Ground test equipment, tools and operator.
- c. Do not handle devices by the leads.
- d. Store devices in conductive foam or carriers.
- e. Avoid use of plastic, rubber, or silk in MOS areas.
- f. Maintain relative humidity above 50 percent.

**6.7 Changes from previous issue.** Asterisks are not used in this revision to identify changes with respect to the previous issue due to the extensiveness of the changes.

**Custodians:**

Army - ER  
Navy - EC  
Air Force - 17

Preparing activity:  
NASA - NA

Agent:  
DLA - ES

**Review activities:**

Army - MI  
Air Force - 11, 19, 80, 85, 99  
DLA - ES

(Project 5962-0909)

**User activities:**

Army - AR, SM  
Navy - AS, CG, OS, MC, SH

**Civil Agency Coordinating Activity:**

NASA - NA